

## 80C186EC/80C188EC AND 80L186EC/80L188EC 16-BIT HIGH-INTEGRATION EMBEDDED PROCESSORS

- Fully Static Operation
- True CMOS inputs and Outputs
- Integrated Feature Set:
  - Low-Power, Static, Enhanced 8086
     CPU Core
  - Two Independent DMA Supported UARTs, each with an Integral Baud Rate Generator
  - Four Independent DMA Channels
  - 22 Multiplexed I/O Port Pins
  - Two 8259A Compatible
     Programmable Interrupt Controllers
  - Three Programmable 16-Bit Timer/ Counters
  - 32-Bit Watchdog Timer
  - Ten Programmable Chip Selects with Integral Wait-State Generator
  - Memory Refresh Control Unit
  - Power Management Unit
  - On-Chip Oscillator
  - System Level Testing Support (ONCE Mode)
- Direct Addressing Capability to 1 Mbyte Memory and 64 Kbyte I/O
- Low-Power Operating Modes:
  - Idle Mode Freezes CPU Clocks but Keeps Peripherals Active
  - -- Powerdown Mode Freezes All Internal Clocks
  - Powersave Mode Divides All Clocks by Programmable Prescalar

- Available in Extended Temperature Range (-40°C to +85°C)
- Supports 80C187 Numerics Processor Extension (80C186EC only)
- Package Types:
  - 100-Pin EIAJ Quad Flat Pack (QFP)
  - 100-Pin Plastic Quad Flat Pack (PQFP)
  - 100-Pin Shrink Quad Flat Pack (SQFP)
- Speed Versions Available (5V):
  - 25 MHz (80C186EC25/80C188EC25)
  - 20 MHz (80C186EC20/80C188EC20)
  - 13 MHz (80C186EC13/80C188EC13)
- Speed Version Available (3V):
  - 13 MHz (80L186EC13/80L188EC13)
  - 8 MHz (80L186EC8/80L188EC8)

The 80C186EC is a member of the 186 Integrated Processor Family. The 186 Integrated Processor Family incorporates several different VLSI devices all of which share a common CPU architecture: the 8086/8088. The 80C186EC uses the latest high density CHMOS technology to integrate several of the most common system peripherals with an enhanced 8086 CPU core to create a powerful system on a single monolithic silicon die.

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# 80C186EC/80C188EC and 80L186EC/80L188EC 16-Bit High-Integration Embedded Processor

CONTENTS PAGE
INTRODUCTION 1-194
80C186EC CORE ARCHITECTURE         1-194           Bus Interface Unit         1-194           Clock Generator         1-194
80C186EC PERIPHERAL ARCHITECTURE 1-195
Programmable Interrupt Controllers 1-197
Timer/Counter Unit 1-197
Serial Communications Unit 1-197
DMA Unit 1-197
Chip-Select Unit 1-197
I/O Port Unit 1-197
Refresh Control Unit 1-197
Watchdog Timer Unit 1-197
Power Management Unit1-198
80C187 Interface (80C186EC only) 1-198
ONCE Test Mode1-198
PACKAGE INFORMATION 1-198
Prefix Identification 1-198
Pin Descriptions 1-198
Pinout 1-205
Package Thermal Specifications 1-214
ELECTRICAL SPECIFICATIONS 1-215
Absolute Maximum Ratings 1-215

CONTENTS	PAGE
Recommended Connections	. 1-215
DC SPECIFICATIONS	. 1-216
$I_{CC}$ versus Frequency and Voltage $\ldots$	
PDTMR Pin Delay Calculation	. 1-218
AC SPECIFICATIONS	. 1-219
AC Characteristics—80C186EC25	
AC Characteristics—80C186EC20/13 .	
AC Characteristics—80L186EC13	
Relative Timings	
Serial Port Mode 0 Timings	. 1-224
AC TEST CONDITIONS	. 1-225
AC TIMING WAVEFORMS	. 1-225
DERATING CURVES	. 1-228
RESET	. 1-228
BUS CYCLE WAVEFORMS	. 1-231
EXECUTION TIMINGS	. 1-238
INSTRUCTION SET SUMMARY	. 1-239
ERRATA	. 1-245
REVISION HISTORY	. 1-245



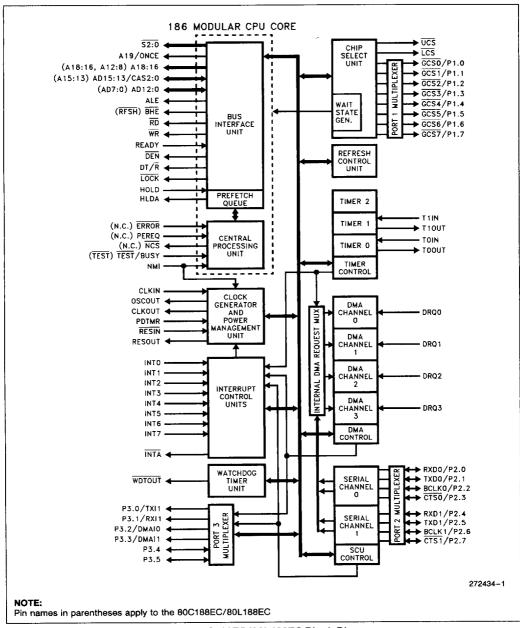


Figure 1. 80C186EC/80L186EC Block Diagram

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#### INTRODUCTION

Unless specifically noted, all references to the 80C186EC apply to the 80C188EC, 80L186EC, and 80L188EC. References to pins that differ between the 80C186EC/80L186EC and the 80C188EC/80L188EC are given in parentheses. The "L" in the part number denotes low voltage operation. Physically and functionally, the "C" and "L" devices are identical.

The 80C186EC is one of the highest integration members of the 186 Integrated Processor Family. Two serial ports are provided for services such as interprocessor communication, diagnostics and modem interfacing. Four DMA channels allow for high speed data movement as well as support of the onboard serial ports. A flexible chip select unit simplifies memory and peripheral interfacing. The three general purpose timer/counters can be used for a variety of time measurement and waveform generation tasks. A watchdog timer is provided to insure system integrity even in the most hostile of environments. Two 8259A compatible interrupt controllers handle internal interrupts, and, up to 57 external interrupt requests. A DRAM refresh unit and 24 multiplexed I/O ports round out the feature set of the 80C186EC.

The future set of the 80C186EC meets the needs of low-power, space-critical applications. Low-power applications benefit from the static design of the CPU and the integrated peripherals as well as low voltage operation. Minimum current consumption is achieved by providing a powerdown mode that halts operation of the device and freezes the clock circuits. Peripheral design enhancements ensure that non-initialized peripherals consume little current.

The 80L186EC is the 3V version of the 80C186EC. The 80L186EC is functionally identical to the 80C186EC embedded processor. Current 80C186EC users can easily upgrade their designs to use the 80L186EC and benefit from the reduced power consumption inherent in 3V operation.

Figure 1 shows a block diagram of the 80C186EC/80C188EC. The execution unit (EU) is an enhanced 8086 CPU core that includes: dedicated hardware to speed up effective address calculations, enhanced execution speed for multiple-bit shift and rotate instructions and for multiply and divide instructions, string move instructions that operate at full bus bandwidth, ten new instructions and fully static operation. The bus interface unit (BIU) is the same as that found on the original 186 family products, except the queue-status mode has been deleted and buffer interface control has been changed to ease system design timings. An independent internal bus is used for communication between the BIU and on-chip peripherals.

#### **80C186EC CORE ARCHITECTURE**

#### **Bus Interface Unit**

The 80C186EC core incorporates a bus controller that generates local bus control signals. In addition, it employs a HOLD/HLDA protocol to share the local bus with other bus masters.

The bus controller is responsible for generating 20 bits of address, read and write strobes, bus cycle status information and data (for write operations) information. It is also responsible for reading data from the local bus during a read operation. A ready input pin is provided to extend a bus cycle beyond the minimum four states (clocks).

The bus controller also generates two control signals (DEN and DT/R) when interfacing to external transceiver chips. This capability allows the addition of transceivers for simple buffering of the multiplexed address/data bus.

#### **Clock Generator**

The 80C186EC provides an on-chip clock generator for both internal and external clock generation. The clock generator features a crystal oscillator, a divide-by-two counter and three low-power operating modes.

The oscillator circuit is designed to be used with either a parallel resonant fundamental or third-overtone mode crystal network. Alternatively, the oscillator circuit may be driven from an external clock source. Figure 2 shows the various operating modes of the oscillator circuit.

The crystal or clock frequency chosen must be twice the required processor operating frequency due to the internal divide-by-two counter. This counter is used to drive all internal phase clocks and the external CLKOUT signal. CLKOUT is a 50% duty cycle processor clock and can be used to drive other system components. All AC timings are referenced to CLKOUT.

The following parameters are recommended when choosing a crystal:

Temperature Range: Application Specific ESR (Equivalent Series Res.):  $40\Omega$  max C0 (Shunt Capacitance of Crystal): 7.0 pF max C<sub>L</sub> (Load Capacitance): 20 pF  $\pm 2$  pF Drive Level: 1 mW (max)

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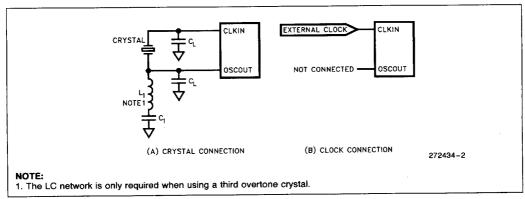


Figure 2. 80C186EC Clock Connections

## 80C186EC PERIPHERAL ARCHITECTURE

The 80C186EC integrates several common system peripherals with a CPU core to create a compact, yet powerful system. The integrated peripherals are designed to be flexbile and provide logical interconnections between supporting units (e.g., the DMA unit can accept requests from the Serial Communications Unit).

The list of integrated peripherals includes:

- Two cascaded, 8259A compatible, Programmable Interrupt Controllers
- 3-Channel Timer/Counter Unit
- 2-Channel Serial Communications Unit
- 4-Channel DMA Unit

- 10-Output Chip-Select Unit
- 32-bit Watchdog Timer Unit
- I/O Port Unit
- Refresh Control Unit
- Power Management Unit

The registers associated with each integrated peripheral are contained within a 128 x 16-bit register file called the Peripheral Control Block (PCB). The base address of the PCB is programmable and can be located on any 256 byte address boundary in either memory or I/O space.

Figure 3 provides a list of the registers associated with the PCB. The Register Bit Summary individually lists all of the registers and identifies each of their programming attributes.



PCB Offset	Function
00H	Master PIC Port 0
02H	Master PIC Port 1
04H	Slave PIC Port 0
06H	Slave PIC Port 1
08H	Reserved
0AH	SCU Int. Req. Ltch.
осн	DMA Int. Req. Ltch.
0EH	TCU Int. Req. Ltch.
10H	Reserved
12H	Reserved
14H	Reserved
16H	Reserved
18H	Reserved
1AH	Reserved
1CH	Reserved
1EH	Reserved
20H	WDT Reload High
22H	WDT Reload Low
24H	WDT Count High
26H	WDT Count Low
28H	WDT Clear
2AH	WDT Disable
2CH	Reserved
2EH	Reserved
30H	T0 Count
32H	T0 Compare A
34H	T0 Compare B
46H	T0 Control
38H	T1 Count
зан	T1 Compare A
зсн	T1 Compare B
3ЕН	T1 Control

40H         T2 Count           42H         T2 Compare           44H         Reserved           46H         T2 Control           48H         Port 3 Direction           4AH         Port 3 Pin State           4CH         Port 3 Mux Control           4EH         Port 3 Data Latch           50H         Port 1 Direction           52H         Port 1 Pin State           54H         Port 1 Mux Control           58H         Port 2 Direction           5AH         Port 2 Pin State           5CH         Port 2 Mux Control           5EH         Port 2 Data Latch           60H         SCU 0 Baud           62H         SCU 0 Control           64H         SCU 0 Control           66H         SCU 0 Status           68H         SCU 0 TBUF           6CH         Reserved           70H         SCU 1 Baud           72H         SCU 1 Count           74H         SCU 1 Control           76H         SCU 1 Status           78H         SCU 1 TBUF           7CH         Reserved           7EH         Reserved	PCB Offset	Function	
44H Reserved 46H T2 Control 48H Port 3 Direction 4AH Port 3 Pin State 4CH Port 3 Mux Control 4EH Port 1 Direction 52H Port 1 Direction 52H Port 1 Mux Control 56H Port 1 Data Latch 56H Port 2 Direction 5AH Port 2 Direction 5AH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 RBUF 6AH SCU 0 TBUF 6CH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF	40H	T2 Count	
46H T2 Control 48H Port 3 Direction 4AH Port 3 Pin State 4CH Port 3 Mux Control 4EH Port 3 Data Latch 50H Port 1 Direction 52H Port 1 Pin State 54H Port 1 Data Latch 56H Port 1 Data Latch 56H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF 7CH Reserved	42H	T2 Compare	
48H Port 3 Direction 4AH Port 3 Pin State 4CH Port 3 Mux Control 4EH Port 3 Data Latch 50H Port 1 Direction 52H Port 1 Pin State 54H Port 1 Mux Control 56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Control 64H SCU 0 Control 66H SCU 0 TBUF 6CH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	44H	Reserved	
4AH Port 3 Pin State 4CH Port 3 Mux Control 4EH Port 3 Data Latch 50H Port 1 Direction 52H Port 1 Pin State 54H Port 1 Mux Control 56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF	46H	T2 Control	
4CH Port 3 Mux Control 4EH Port 3 Data Latch 50H Port 1 Direction 52H Port 1 Pin State 54H Port 1 Mux Control 56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Mux Control 6CH SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF	48H	Port 3 Direction	
4EH Port 3 Data Latch 50H Port 1 Direction 52H Port 1 Pin State 54H Port 1 Mux Control 56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Control 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6CH Reserved 70H SCU 1 Baud 72H SCU 1 Control 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF	4AH	Port 3 Pin State	
50H Port 1 Direction 52H Port 1 Pin State 54H Port 1 Mux Control 56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Control 64H SCU 0 Control 66H SCU 0 TBUF 6CH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	4CH	Port 3 Mux Control	
52H Port 1 Pin State 54H Port 1 Mux Control 56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6CH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF	4EH	Port 3 Data Latch	
54H Port 1 Mux Control 56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6AH SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF	50H	Port 1 Direction	
56H Port 1 Data Latch 58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6CH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF	52H	Port 1 Pin State	
58H Port 2 Direction 5AH Port 2 Pin State 5CH Port 2 Mux Control 5EH Port 2 Data Latch 60H SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 RBUF 7AH SCU 1 TBUF	54H	Port 1 Mux Control	
5AH         Port 2 Pin State           5CH         Port 2 Mux Control           5EH         Port 2 Data Latch           60H         SCU 0 Baud           62H         SCU 0 Count           64H         SCU 0 Control           66H         SCU 0 Status           68H         SCU 0 RBUF           6AH         SCU 0 TBUF           6CH         Reserved           70H         SCU 1 Baud           72H         SCU 1 Count           74H         SCU 1 Control           76H         SCU 1 Status           78H         SCU 1 RBUF           7AH         SCU 1 TBUF           7CH         Reserved	56H	Port 1 Data Latch	
5CH         Port 2 Mux Control           5EH         Port 2 Data Latch           60H         SCU 0 Baud           62H         SCU 0 Count           64H         SCU 0 Control           66H         SCU 0 Status           68H         SCU 0 RBUF           6AH         SCU 0 TBUF           6CH         Reserved           70H         SCU 1 Baud           72H         SCU 1 Count           74H         SCU 1 Control           76H         SCU 1 Status           78H         SCU 1 RBUF           7AH         SCU 1 TBUF           7CH         Reserved	58H	Port 2 Direction	
5EH         Port 2 Data Latch           60H         SCU 0 Baud           62H         SCU 0 Count           64H         SCU 0 Control           66H         SCU 0 Status           68H         SCU 0 RBUF           6AH         SCU 0 TBUF           6CH         Reserved           70H         SCU 1 Baud           72H         SCU 1 Count           74H         SCU 1 Control           76H         SCU 1 Status           78H         SCU 1 RBUF           7AH         SCU 1 TBUF           7CH         Reserved	5AH	Port 2 Pin State	
60H SCU 0 Baud 62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6AH SCU 0 TBUF 6CH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF 7AH SCU 1 TBUF	5CH	Port 2 Mux Contro	
62H SCU 0 Count 64H SCU 0 Control 66H SCU 0 Status 68H SCU 0 TBUF 6AH SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 TBUF 7AH SCU 1 TBUF 7CH Reserved	5EH	Port 2 Data Latch	
64H         SCU 0 Control           66H         SCU 0 Status           68H         SCU 0 RBUF           6AH         SCU 0 TBUF           6CH         Reserved           6EH         Reserved           70H         SCU 1 Baud           72H         SCU 1 Count           74H         SCU 1 Control           76H         SCU 1 Status           78H         SCU 1 RBUF           7AH         SCU 1 TBUF           7CH         Reserved	60H	SCU 0 Baud	
66H SCU 0 Status 68H SCU 0 RBUF 6AH SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	62H	SCU 0 Count	
68H SCU 0 RBUF 6AH SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	64H	SCU 0 Control	
6AH SCU 0 TBUF 6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	66H	SCU 0 Status	
6CH Reserved 6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	68H	SCU 0 RBUF	
6EH Reserved 70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	6AH	SCU 0 TBUF	
70H SCU 1 Baud 72H SCU 1 Count 74H SCU 1 Control 76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	6CH	Reserved	
72H         SCU 1 Count           74H         SCU 1 Control           76H         SCU 1 Status           78H         SCU 1 RBUF           7AH         SCU 1 TBUF           7CH         Reserved	6EH	Reserved	
74H         SCU 1 Control           76H         SCU 1 Status           78H         SCU 1 RBUF           7AH         SCU 1 TBUF           7CH         Reserved	70H	SCU 1 Baud	
76H SCU 1 Status 78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	72H	SCU 1 Count	
78H SCU 1 RBUF 7AH SCU 1 TBUF 7CH Reserved	74H	SCU 1 Control	
7AH SCU 1 TBUF 7CH Reserved	76H	SCU 1 Status	
7CH Reserved	78H	SCU 1 RBUF	
	7AH	SCU 1 TBUF	
7EH Reserved	7CH	Reserved	
	7EH	Reserved	

PCB Offset	Function
вон	GCS0 Start
82H	GCS0 Stop
84H	GCS1 Start
86H	GCS1 Stop
88H	GCS2 Start
ван	GCS2 Stop
8CH	GCS3 Start
8EH	GCS3 Stop
90H	GCS4 Start
92H	GCS4 Stop
94H	GCS5 Start
96H	GCS5 Stop
98H	GCS6 Start
9AH	GCS6 Stop
9CH	GCS7 Start
9EH	GCS7 Stop
AOH	LCS Start
A2H	LCS Stop
A4H	UCS Start
А6Н	UCS Stop
A8H	Relocation Register
AAH	Reserved
ACH	Reserved
AEH	Reserved
вон	Refresh Base Addr.
в2н	Refresh Time
В4Н	Refresh Control
в6н	Refresh Address
ввн	Power Control
ВАН	Reserved
всн	Step ID
BEH	Powersave

PCB Offset	Function
СОН	DMA 0 Source Low
C2H	DMA 0 Source High
C4H	DMA 0 Dest. Low
С6Н	DMA 0 Dest. High
С8Н	DMA 0 Count
CAH	DMA 0 Control
ссн	DMA Module Pri.
CEH	DMA Halt
DOH	DMA 1 Source Low
D2H	DMA 1 Source High
D4H	DMA 1 Dest. Low
D6H	DMA 1 Dest. High
D8H	DMA 1 Count
DAH	DMA 1 Control
DCH	Reserved
DEH	Reserved
E0H	DMA 2 Source Low
E2H	DMA 2 Source High
E4H	DMA 2 Dest. Low
E6H	DMA 2 Dest. High
E8H	DMA 2 Count
EAH	DMA 2 Control
ECH	Reserved
EEH	Reserved
FOH	DMA 3 Source Low
F2H	DMA 3 Source High
F4H	DMA 3 Dest. Low
F6H	DMA 3 Dest, High
F8H	DMA 3 Count
FAH	DMA 3 Control
FCH	Reserved

Figure 3. Peripheral Control Block Registers

Reserved

FEH



#### **Programmable Interrupt Controllers**

The 80C186EC utilizes two 8259A compatible Programmable Interrupt Controllers (PIC) to manage both internal and external interrupts. The 8259A modules are configured in a master/slave arrangement.

Seven of the external interrupt pins, INT0 through INT6, are connected to the master 8259A module. The eighth external interrupt pin, INT7, is connected to the slave 8259A module.

There are a total of 11 internal interrupt sources from the integrated peripherals: 4 Serial, 4 DMA and 3 Timer/Counter.

#### **Timer/Counter Unit**

The 80C186EC Timer/Counter Unit (TCU) provides three 16-bit programmable timers. Two of these are highly flexible and are connected to external pins for external control or clocking. The third timer is not connected to any external pins and can only be clocked internally. However, it can be used to clock the other two timer channels. The TCU can be used to count external events, time external events, generate non-repetitive waveforms or generate timed interrupts.

#### **Serial Communications Unit**

The 80C186EC Serial Communications Unit (SCU) contains two independent channels. Each channel is identical in operation except that only channel 0 is directly supported by the integrated interrupt controller (the channel 1 interrupts are routed to external interrupt pins). Each channel has its own baud rate generator and can be internally or externally clocked up to one half the processor operating frequency. Both serial channels can request service from the DMA unit thus providing block reception and transmission without CPU intervention.

Independent baud rate generators are provided for each of the serial channels. For the asynchronous modes, the generator supplies an 8x baud clock to both the receive and transmit shifting register logic. A 1x baud clock is provided in the synchronous mode.

#### **DMA** Unit

The four channel Direct Memory Access (DMA) Unit is comprised of two modules with two channels each. All four channels are identical in operation. DMA transfers can take place from memory to memory, I/O to memory, memory to I/O or I/O to I/O.

DMA requests can be external (on the DRQ pins), internal (from Timer 2 or a serial channel) or software initiated.

The DMA Unit transfers data as bytes only. Each data transfer requires at least two bus cycles, one to fetch data and one to deposit. The minimum clock count for each transfer is 8, but this will vary depending on synchronization and wait states.

#### **Chip-Select Unit**

The 80C186EC Chip-Select Unit (CSU) integrates logic which provides up to ten programmable chip-selects to access both memories and peripherals. In addition, each chip-select can be programmed to automatically insert additional clocks (wait states) into the current bus cycle, and/or automatically terminate a bus cycle independent of the condition of the READY input pin.

#### I/O Port Unit

The I/O Port Unit on the 80C186EC supports two 8-bit channels and one 6-bit channel of input, output or input/output operation. Port 1 is multiplexed with the chip select pins and is output only. Port 2 is multiplexed with the pins for serial channels 1 and 2. All Port 2 pins are input/output. Port 3 has a total of 6 pins: four that are multiplexed with DMA and serial port interrupts and two that are non-multiplexed, open drain I/O.

#### Refresh Control Unit

The Refresh Control Unit (RCU) automatically generates a periodic memory read bus cycle to keep dynamic or pseudo-static memory refreshed. A 9-bit counter controls the number of clocks between refresh requests.

A 12-bit address generator is maintained by the RCU and is presented on the A12:1 address lines during the refresh bus cycle. Address bits A19:13 are programmable to allow the refresh address block to be located on any 8 Kbyte boundary.

#### **Watchdog Timer Unit**

The Watchdog Timer Unit (WDT) allows for graceful recovery from unexpected hardware and software upsets. The WDT consists of a 32-bit counter that decrements every clock cycle. If the counter reaches zero before being reset, the WDTOUT pin is

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pulled low for four clock cycles. Logically ANDing the WDTOUT pin with the power-on reset signal allows the WDT to reset the device in the event of a WDT timeout. If a less drastic method of recovery is desired, WDTOUT can be connected directly to NMI or one of the INT input pins. The WDT may also be used as a general purpose timer.

#### **Power Management Unit**

The 80C186EC Power Management Unit (PMU) is provided to control the power consumption of the device. The PMU provides four power management modes: Active, Powersave, Idle and Powerdown.

Active Mode indicates that all units on the 80C186EC are operating at 1/2 the CLKIN frequency.

Idle Mode freezes the clocks of the Execution and Bus units at a logic zero state (all peripherals continue to operate normally).

The Powerdown Mode freezes all internal clocks at a logic zero level and disables the crystal oscillator.

In Powersave Mode, all internal clock signals are divided by a programmable prescalar (up to 1/64 the normal frequency). Powersave Mode can be used with Idle Mode as well as during normal (Active Mode) operation.

### 80C187 Interface (80C186EC only)

The 80C186EC supports the direct connection of the 80C187 Numerics Processor Extension. The 80C187 can dramatically improve the performance of calculation intensive applications.

#### **ONCE Test Mode**

To facilitate testing and inspection of devices when fixed into a target system, the 80C186EC has a test mode available which forces all output and input/output pins to be placed in the high-impedance state. ONCE stands for "ON Circuit Emulation". The ONCE mode is selected by forcing the A19/S6/ONCE pin low during a processor reset (this pin is weakly held high during reset to prevent inadvertant entrance into ONCE Mode).

#### PACKAGE INFORMATION

This section describes the pin functions, pinout and thermal characteristics for the 80C186EC in the Plastic Quad Flat Pack (JEDEC PQFP), the EIAJ Quad Flat Pack (QFP) and the Shrink Quad Flat Pack (SQFP). For complete package specifications

and information, see the Intel Packaging Outlines and Dimensions Guide (Order Number: 231369).

#### Prefix Identification

Table 1 lists the prefix identifications.

Table 1. Prefix Identification

Prefix	Note	Package Type	Temperature Range
TS		QFP (EIAJ)	Extended
KU	1	PQFP	Extended/Commercial
SB	1	SQFP	Extended/Commercial
S	1	QFP (EIAJ)	Commercial

#### NOTE:

 The 5V 25 MHz version is only available in commercial temperature range corresponding to 0°C to +70°C ambiost

#### Pin Descriptions

Each pin or logical set of pins is described in Table 2. There are four columns for each entry in the Pin Description Table. The following sections describe each column.

#### Column 1: Pin Name

In this column is a mnemonic that describes the pin function. Negation of the signal name (i.e. RESIN) implies that the signal is active low.

#### Column 2: Pin Type

A pin may be either power (P), ground (G), input only (I), output only (O) or input/output (I/O). Please note that some pins have more than 1 function. A19/S6/ONCE, for example, is normally an output but functions as an input during reset. For this reason A19/S6/ONCE is classified as an input/output pin.

### Column 3: Input Type (for I and I/O types only)

There are two different types of input pins on the 80C186EC: asynchronous and synchronous. Asynchronous pins require that setup and hold times be met only to guarantee recognition. Synchronous input pins require that the setup and hold times be met to guarantee proper operation. Stated simply, missing a setup or hold on an asynchronous pin will result in something minor (i.e. a timer count will be missed) whereas missing a setup or hold on a synchronous pin will result in system failure (the system will "lock up").

An input pin may also be edge or level sensitive.

1-198

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## Column 4: Output States (for O and I/O types only)

The state of an output or I/O pin is dependent on the operating mode of the device. There are four modes of operation that are different from normal active mode: Bus Hold, Reset, Idle Mode, Powerdown Mode. This column describes the output pin state in each of these modes.

The legend for interpreting the information in the Pin Descriptions is shown in Table 1.

As an example, please refer to the table entry for AD12:0. The "I/O" signifies that the pins are bidirectional (i.e. have both an input and output function). The "S" indicates that, as an input the signal must be synchronized to CLKOUT for proper operation. The "H(Z)" indicates that these pins will float while

the processor is in the Hold Acknowledge state. R(Z) indicates that these pins will float while  $\overline{RESIN}$  is low. P(0) and I(0) indicate that these pins will drive 0 when the device is in either Powerdown or Idle Mode.

Some pins, the I/O Ports for example, can be programmed to perform more than one function. Multifunction pins have a "/" in their signal name between the different functions (i.e. P3.0/RXI1). If the input pin type or output pin state differ between functions, then that will be indicated by separating the state (or type) with a "/" (i.e. H(X)/H(Q)). In this example when the pin is configured as P3.0 then its hold output state is H(X); when configured as RXI1 its output state is H(Q).

All pins float while the processor is in the ONCE Mode (with the exception of OSCOUT).

**Table 1. Pin Description Nomenclature** 

Symbol	Description
P G I O I/O	Power Pin (apply + V <sub>CC</sub> voltage) Ground (connect to V <sub>SS</sub> ) Input only pin Output only pin Input/Output pin
S(E) S(L) A(E) A(L)	Synchronous, edge sensitive Synchronous, level sensitive Asynchronous, edge sensitive Asynchronous, level sensitive
H(1) H(0) H(Z) H(Q) H(X)	Output driven to V <sub>CC</sub> during bus hold Output driven to V <sub>SS</sub> during bus hold Output floats during bus hold Output remains active during bus hold Output retains current state during bus hold
R(WH) R(1) R(0) R(Z) R(Q) R(X)	Output weakly held at $V_{CC}$ during reset Output driven to $V_{CC}$ during reset Output driven to $V_{SS}$ during reset Output floats during reset Output remains active during reset Output retains current state during reset
I(1) I(0) I(Z) I(Q) I(X)	Output driven to V <sub>CC</sub> during Idle Mode Output driven to V <sub>SS</sub> during Idle Mode Output floats during Idle Mode Output remains active during Idle Mode Output retains current state during Idle Mode
P(1) P(0) P(Z) P(Q) P(X)	Output driven to V <sub>CC</sub> during Powerdown Mode Output driven to V <sub>SS</sub> during Powerdown Mode Output floats during Powerdown Mode Output remains active during Powerdown Mode Output retains current state during Powerdown Mode

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**Table 2. Pin Descriptions** 

Pin Name	Pin Type	Input Type	Output States	Pin Description
V <sub>CC</sub>	Р		_	POWER +5V ±10% power supply connection
V <sub>SS</sub>	G	_	_	GROUND
CLKIN		A(E)		CLock INput is the external clock input. An external oscillator operating at two times the required processor operating frequency can be connected to CLKIN. For crystal operation, CLKIN (along with OSCOUT) are the crystal connections to an internal Pierce oscillator.
OSCOUT	0		H(Q) R(Q) I(Q) P(X)	OSCillator OUTput is only used when using a crystal to generate the internal clock. OSCOUT (along with CLKIN) are the crystal connections to an internal Pierce oscillator. This pin can not be used as 2X clock output for noncrystal applications (i.e. this pin is not connected for noncrystal applications).
CLKOUT	0		H(Q) R(Q) I(Q) P(X)	CLock OUTput provides a timing reference for inputs and outputs of the processor, and is one-half the input clock (CLKIN) frequency. CLKOUT has a 50% duty cycle and transitions every falling edge of CLKIN.
RESIN		A(L)		RESet IN causes the processor to immediately terminate any bus cycle in progress and assume an initialized state. All pins will be driven to a known state, and RESOUT will also be driven active. The rising edge (low-to-high) transition synchronizes CLKOUT with CLKIN before the processor begins fetching opcodes at memory location 0FFFF0H.
RESOUT	0	+	H(0) R(1) I(0) P(0)	<b>RESet OUTput</b> that indicates the processor is currently in the reset state. RESOUT will remain active as long as RESIN remains active.
PDTMR	1/0	A(L)	H(WH) R(Z) P(WH) I(WH)	Power-Down TiMeR pin (normally connected to an external capacitor) that determines the amount of time the processors waits after an exit from Powerdown before resuming normal operation. The duration of time required will depend on the startup characteristics of the crystal oscillator.
NMI	1	A(E)	_	Non-Maskable Interrupt input causes a TYPE-2 interrupt to be serviced by the CPU. NMI is latched internally.
TEST/BUSY (TEST)		A(E)		TEST is used during the execution of the WAIT instruction to suspend CPU operation until the pin is sampled active (LOW). TEST is alternately known as BUSY when interfacing with an 80C187 numerics coprocessor (80C186EC only).
A19/S6/ONCE	1/0	A(L)	H(Z) R(WH) I(0) P(0)	This pin drives address bit 19 during the address phase of the bus cycle. During T2 and T3 this pin functions as status bit 6. S6 is low to indicate CPU bus cycles and high to indicate DMA or refresh bus cycles. During a processor reset (RESIN active) this pin becomes the ONCE input pin. Holding this pin low during reset will force the part into ONCE Mode.

#### NOTE:

1-200

Pin names in parentheses apply to the 80C188EC/80L188EC.

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Table 2. Pin Descriptions (Continued)

Pin Name	Pin Type	Input Type	Output States		scriptioi	-	Pin Description
A18/S5 A17/S4 A16/S3 (A15:8)	1/0	A(L)	H(Z) R(WH) I(0) P(0)	These pins drive address information during the address phase of the bus cycle. During T2 and T3 these pins drive status information (which is always 0 on the 80C186EC). These pins are used as inputs during factory test; driving these pins low during reset will cause unspecified operation. On the 80C188EC, A15:8 provide valid address information for the entire bus cycle.			
AD15/CAS2 AD14/CAS1 AD13/CAS0	1/0	S(L)	H(Z) R(Z) I(0) P(0)	bus. 15 th latch data 82Cs	During the cough 10 phase of the cough the cou	ne add 3 are p ALE. f the b addres	of the multiplexed ADDRESS and DATA ress phase of the bus cycle, address bits resented on these pins and can be Data information is transferred during the us cycle. Pins AD15:13/CAS2:0 drive the ss information during interrupt s.
AD12:0 (AD7:0)	1/0	S(L)	H(Z) R(Z) I(0) P(0)	Durir throu the b	ng the ad ugh 12 (0 ous and d	Idress through an be	a multiplexed ADDRESS and DATA bus. phase of the bus cycle, address bits 0 gh 7 on the 80C188EC) are presented on latched using ALE. Data information is the data phase of the bus cycle.
\$2:0	0	_	H(Z) R(1) l(1)				e encoded on these pins to provide bus tion. S2:0 are encoded as follows:
			P(1)	<u>\$2</u>	<u>\$1</u>	<u>50</u>	Bus Cycle Initiated
				0 0 0 0 1 1 1	0 0 1 1 0 0	0 1 0 1 0 1	Interrupt Acknowledge Read I/O Write I/O Processor HALT Instruction Queue Fetch Read Memory Write Memory Passive (No bus activity)
ALE	0	_	H(0) R(0) I(0) P(0)	Add infor	ress Lat	ch En	able output is used to strobe address ansparent type latch during the address
BHE (RFSH)	0	_	H(Z) R(Z) I(1) P(1)	prog	ress is tr	ansfer	output to indicate that the bus cycle in ring data over the upper half of the data ave the following logical encoding:
				A0	BHE		Encoding (for 80C186EC/ 80L186EC only)
				0 0 1 1	0 1 0		Word transfer Even Byte transfer Odd Byte transfer Refresh operation
							80L188EC, RFSH is asserted low to us cycle.

#### NOTE:

Pin names in parentheses apply to the 80C188EC/80L188EC.

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Table 2. Pin Descriptions (Continued)

Pin Name	Pin	Input	Output	Rin Descriptions (COntinues)
Pin Name	Type	Туре	States	Pin Description
RD	0		H(Z) R(Z) I(1) P(1)	ReaD output signals that the accessed memory or I/O device should drive data information onto the data bus.
WR	0		H(Z) R(Z) I(1) P(1)	WRIte output signals that data available on the data bus are to be written into the accessed memory or I/O device.
READY	ı	A(L) S(L) (Note 1)	_	<b>READY</b> input to signal the completion of a bus cycle. READY must be active to terminate any 80C186EC bus cycle, unless it is ignored by correctly programming the Chip-Select unit.
DEN	0	ı	H(Z) R(Z) I(1) P(1)	Data ENable output to control the enable of bi-directional transceivers in a buffered system. DEN is active only when data is to be transferred on the bus.
DT/Ā	0	<del></del> -	H(Z) R(Z) I(X) P(X)	Data Transmit/Receive output controls the direction of a bi- directional buffer in a buffered system.
LOCK	1/0	A(L)	H(Z) R(Z) I(X) P(X)	LOCK output indicates that the bus cycle in progress is not interruptable. The processor will not service other bus requests (such as HOLD) while LOCK is active. This pin is configured as a weakly held high input while RESIN is active and must not be driven low.
HOLD		A(L)	<u> </u>	HOLD request input to signal that an external bus master wishes to gain control of the local bus. The processor will relinquish control of the local bus between instruction boundaries that are not LOCKed.
HLDA	0	_	H(1) R(0) I(0) P(0)	HoLD Acknowledge output to indicate that the processor has relinquished control of the local bus. When HLDA is asserted, the processor will (or has) floated its data bus and control signals allowing another bus master to drive the signals directly.
NCS	0		H(1) R(1) I(1) P(1)	Numerics Coprocessor Select output is generated when acessing a numerics coprocessor. This signal does not exist on the 80C188EC/80L188EC.
ERROR	1	A(L)		ERROR input that indicates the last numerics processor extension operation resulted in an exception condition. An interrupt TYPE 16 is generated if ERROR is sampled active at the beginning of a numerics operation. Systems not using an 80C187 must tie ERROR to V <sub>CC</sub> . This signal does not exist on the 80C188EC/80L188EC.

Pin names in parentheses apply to the 80C188EC/80L188EC.

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Table 2. Pin Descriptions (Continued)

Table 2. Pin Descriptions (Continued)						
Pin Name	Pin Type	Input Type	Output States	Pin Description		
PEREQ	l	A(L)		Processor Extension REQuest signals that a data transfer between an 80C187 Numerics Processor Extension and Memory is pending. Systems not using an 80C187 must tie this pin to V <sub>SS</sub> . This signal does not exist on the 80C188EC/80L188EC.		
UCS	0	-	H(1) R(1) I(1) P(1)	<b>Upper Chip Select</b> will go active whenever the address of a memory or I/O bus cycle is within the address range programmed by the user. After reset, UCS is configured to be active for memory accesses between 0FFC00H and 0FFFFFH.		
LCS	0	—	H(1) R(1) I(1) P(1)	<b>Lower Chip Select</b> will go active whenever the address of a memory or I/O bus cycle is within the address range programmed by the user. <u>LCS</u> is inactive after a reset.		
P1.0/GCS0 P1.1/GCS1 P1.2/GCS2 P1.3/GCS3 P1.4/GCS4 P1.5/GCS5 P1.6/GCS6 P1.7/GCS7	O	-	H(X)/H(1) R(1) I(X)/I(1) P(X)/P(1)	These pins provide a multiplexed function. If enabled, each pin can provide a <b>General purpose Chip Select</b> output which will go active whenever the address of a memory or I/O bus cycle is within the address limitations programmed by the user. When not programmed as a Chip-Select, each pin may be used as a general purpose output port.		
T0OUT T1OUT	0	<del>_</del>	H(Q) R(1) I(Q) P(X)	Timer OUTput pins can be programmed to provide single clock or continuous waveform generation, depending on the timer mode selected.		
TOIN T1IN	1	A(L) A(E)	_	Timer INput is used either as clock or control signals, depending on the timer mode selected. This pin may be either level or edge sensitive depending on the programming mode.		
INT7:0	1	A(L) A(E)	1	Maskable INTerrupt input will cause a vector to a specific Type interrupt routine. The INT6:0 pins can be used as cascade inputs from slave 8259A devices. The INT pins can be configured as level or edge sensitive.		
ĪNTA	0	_	H(1) R(1) I(1) P(1)	INTerrupt Acknowledge output is a handshaking signal used by external 82C59A Programmable Interrupt Controllers.		
P3.5 P3.4	1/0	A(L)	H(X) R(Z) I(X) H(X)	Bidirectional, open-drain port pins.		
P3.3/DMAI1 P3.2/DMAI0	0	<u> </u>	H(X) R(0) I(Q) P(X)	DMA Interrupt output goes active to indicate that the channel has completed a transfer. DMAI1 and DMAI0 are multiplexed with output only port functions.		

NOTE:

Pin names in parentheses apply to the 80C188EC/80L188EC.

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Table 2. Pin Descriptions (Continued)

Table 2. Pin Descriptions (Continued)				
Pin Name	Pin Type	Input Type	Output States	Pin Description
P3.1/TXI1	0		H(X)/H(Q) R(0) I(Q) P(X)	Transmit Interrupt output goes active to indicate that serial channel 1 has completed a transfer. TXI1 is multiplexed with an output only Port function.
P3.0/RXI1	0		H(X)/H(Q) R(0) I(Q) P(X)	Receive Interrupt output goes active to indicate that serial channel 1 has completed a reception. RXI1 is multiplexed with an output only port function.
WDTOUT	0	<del></del>	H(Q) R(1) I(Q) P(X)	WatchDog Timer OUTput is driven low for four clock cycles when the watchdog timer reaches zero. WDTOUT may be ANDed with the power-on reset signal to reset the processor when the watchdog timer is not properly reset.
P2.7/ <u>CTS1</u> P2.3/ <u>CTS0</u>	1/0	A(L)	H(X) R(Z) I(X) P(X)	Clear-To-Send input is used to prevent the transmission of serial data on the TXD signal pin. CTS1 and CTS0 are multiplexed with an I/O Port function.
P2.6/BCLK1 P2.2/BCLK0	1/0	A(L)/ A(E)	H(X) R(Z) I(X) P(X)	Baud CLock input can be used as an alternate clock source for each of the integrated serial channels. The BCLK inputs are multiplexed with I/O Port functions. The BCLK input frequency cannot exceed ½ the operating frequency of the processor.
P2.5/TXD1 P2.1/TXD0	1/0	A(L)	H(Q) R(Z) I(X)/I(Q) P(X)	Transmit Data output provides serial data information. The TXD outputs are multiplexed with I/O Port functions. During synchronous serial communications, TXD will function as a clock output.
P2.4/RXD1 P2.0/RXD0	1/0	A(L)	H(X)/H(Q) R(Z) I(X)/I(Q) P(X)	Receive Data input accepts serial data information. The RXD pins are multiplexed with I/O Port functions. During synchronous serial communications, RXD is bi-directional and will become an output for transmission of data (TXD becomes the clock).
DRQ3:0	ı	A(L)		<b>DMA ReQuest</b> input pins are used to request a DMA transfer. The timing of the request is dependent on the programmed synchronization mode.

#### NOTES:

<sup>1.</sup> READY is A(E) for the rising edge of CLKOUT, S(E) for the falling edge of CLKOUT.

<sup>2.</sup> Pin names in parentheses apply to the 80C188EC/80L188EC.



#### **Pinout**

Tables 3 and 4 list the pin names with package location for the 100-pin Plastic Quad Flat Pack (PQFP) component. Figure 4 depicts the PQFP package as viewed from the top side of the component (i.e. contacts facing down).

Tables 5 and 6 list the pin names with package location for the 100-pin EIAJ Quad Flat Pack (QFP) component. Figure 5 depicts the QFP package as viewed

from the top side of the component (i.e. contacts facing down).

Tables 7 and 8 list the pin names with package location for the 100-pin Shrink Quad Flat Pack (SQFP) component. Figure 6 depicts the SQFP package as viewed from the top side of the component (i.e., contacts facing down).

Table 3. PQFP Pin Functions with Location

AD Bus		
Name	Pin	
AD0	73	
AD1	72	
AD2	71	
AD3	70	
AD4	66	
AD5	65	
AD6	64	
AD7	63	
AD8 (A8)	60	
AD9 (A9)	59	
AD10 (A10)	58	
AD11 (A11)	57	
AD12 (A12)	56	
AD13/CAS0	55	
(A13/CAS0)		
AD14/CAS1	54	
(A14/CAS1)		
AD15/CAS2	53	
(A15/CAS2)		
A16/S3	77	
A17/S4	76	
A18/S5	75	
A19/S6/ONCE	74	

Bus Control			
Name	Pin		
ALE	52		
BHE (RFSH)	51		
<u>50</u>	78		
<del>\$</del> 1	79		
S2	80		
RD	50		
WR	49		
READY	85		
DEN	47		
DT/R	46		
LOCK	48		
HOLD	44		
HLDA	45		
ĪNTA	34		

Power and Ground			
Name	Pin		
$v_{cc}$	13		
$V_{CC}$	14		
V <sub>C</sub> C	38		
Vcc	62		
V <sub>CC</sub>	67		
Vcc	69		
Vcc	86		
V <sub>SS</sub>	12		
Vss	15		
Vss	37		
Vss	39		
Vss	61		
Vss	68		
Vss	87		

Processor Control		
Name	Pin	
RESIN	8	
RESOUT	7	
CLKIN	10	
OSCOUT	11	
CLKOUT	6	
TEST/BUSY	83	
(TEST)		
PEREQ (VSS)	81	
NCS (N.C.)	35	
ERROR (V <sub>CC</sub> )	84	
PDTMR	9	
NMI	82	
INT0	30	
INT1	31	
INT2	32	
INT3	33	
INT4	40	
INT5	41	
INT6	42	
INT7	43	

Name	Pin
UCS	88
LCS	89
P1.7/GCS7	90
P1.6/GCS6	91
P1.5/GCS5	92
P1.4/GCS4	93
P1.3/GCS3	94
P1.2/GCS2	95
P1.1/GCS1	96
P1.0/GCS0	97
P2.7/CTS1 P2.6/BCLK1 P2.5/TXD1 P2.4/RXD1 P2.3/CTS0 P2.2/BCLK0 P2.1/TXD0 P2.0/RXD0	23 22 21 20 19 18 17
P3.5	29
P3.4	28
P3.3/DMAI1	27
P3.2/DMAI0	26
P3.1/TXI1	25
P3.0/RXI1	24
TOIN	3
TOOUT	2
T1IN	5
T1OUT	4
DRQ0	98
DRQ1	99
DRQ2	100
DRQ3	1
WDTOUT	36

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Table 4. PQFP Pin Locations with Pin Name

Pin	Name		Pin	Name
1	DRQ3		26	DMAI0/P3.2
2	TOOUT		27	DMAI1/P3.3
3	TOIN		28	P3.4
4	T1OUT		29	P3.5
5	T1IN		30	INTO
6	CLKOUT		31	INT1
7	RESOUT		32	INT2
8	RESIN		33	INT3
9	PDTMR		34	ĪNTA
10	CLKIN		35	NCS (N.C.)
11	OSCOUT		36	WDTOUT
12	V <sub>SS</sub>		37	V <sub>SS</sub>
13	Vcc		38	Vcc
14	V <sub>CC</sub>		39	V <sub>SS</sub>
15	V <sub>SS</sub>		40	INT4
16	P2.0/RXD0		41	INT5
17	P2.1/TXD0		42	INT6
18	P2.2/BCLK0		43	INT7
19	P2.3/CTS0		44	HOLD
20	P2.4/RXD1		45	HLDA
21	P2.5/TXD1		46	DT/R
22	P2.6/BCLK1		47	DEN
23	P2.7/CTS1	Ì	48	LOCK
24	P3.0/RXI1		49	WR
25	P3.1/TXI1		50	RD

ZEIOTIS WIEIT III NAUTIC		
Pin	Name	
51	BHE (RFSH)	
52	ALE	
53	AD15 (A15)	
54	AD14 (A14)	
55	AD13 (A13)	
56	AD12 (A12)	
57	AD11 (A11)	
58	AD10 (A10)	
59	AD9 (A9)	
60	AD8 (A8)	
61	$V_{SS}$	
62	V <sub>CC</sub>	
63	AD7	
64	AD6	
65	AD5	
66	AD4	
67	V <sub>CC</sub>	
68	V <sub>SS</sub>	
69	V <sub>CC</sub>	
70	AD3	
71	AD2	
72	AD1	
73	AD0	
74	A19/S6/ONCE	
75	A18/\$5	

Pin	Name
76	A17/S4
77	A16/S3
78	<u>50</u>
79	<u>81</u>
80	S2
81	PEREQ (VSS)
82	NMI
83	TEST
84	ERROR (V <sub>CC</sub> )
85	READY
86	Vcc
87	V <sub>SS</sub>
88	UČS
89	LCS
90	P1.7/GCS7
91	P1.6/GCS6
92	P1.5/GCS5
93	P1.4/GCS4
94	P1.3/GCS3
95	P1.2/GCS2
96	P1.1/GCS1
97	P1.0/GCS0
98	DRQ0
99	DRQ1
100	DRQ2



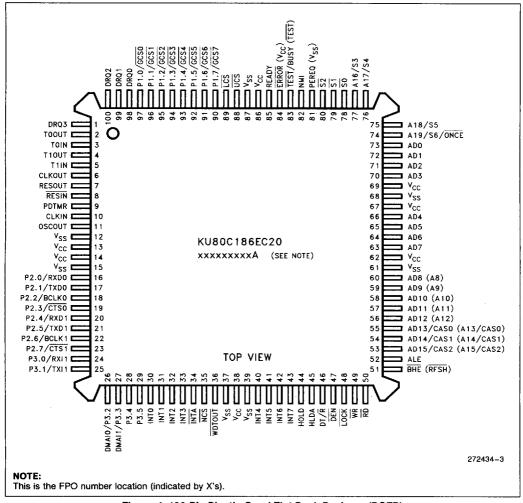


Figure 4. 100-Pin Plastic Quad Flat Pack Package (PQFP)



Table 5. QFP Pin Names with Package Location

AD Bus				
Name	Pin			
AD0	76			
AD1	75			
AD2	74			
AD3	73			
AD4	69			
AD5	68			
AD6	67			
AD7	66			
AD8 (A8)	63			
AD9 (A9)	62			
AD10 (A10)	61			
AD11 (A11)	60			
AD12 (A12)	59			
AD13/CAS0	58			
(A13/CAS0)				
AD14/CAS1	57			
(A14/CAS1)				
AD15/CAS2	56			
(A15/CAS2)				
A16/S3	80			
A17/S4	79			
A18/S5	78			
A19/S6/ONCE	77			

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Bus Control			
Name	Pin		
ALE	55		
BHE (RFSH)	54		
<u>\$0</u>	81		
<u>\$1</u>	82		
<u>\$2</u>	83		
RD	53		
WR	52		
READY	88		
DEN	50		
DT/Ř	49		
LOCK	51		
HOLD	47		
HLDA	48		
ĪNTĀ	37		

Power and Ground			
Name	Pin		
$v_{cc}$	16		
V <sub>CC</sub>	17		
V <sub>CC</sub>	41		
V <sub>CC</sub>	65		
$v_{cc}$	70		
$v_{cc}$	72		
V <sub>CC</sub>	89		
$V_{SS}$	15		
V <sub>SS</sub>	18		
V <sub>SS</sub>	40		
Vss	42		
V <sub>SS</sub>	64		
V <sub>SS</sub>	71		
V <sub>SS</sub>	90		

Processor Control		
Name	Pin	
RESIN	11	
RESOUT	10	
CLKIN	13	
OSCOUT	14	
CLKOUT	9	
TEST/BUSY	86	
(TEST)		
PEREQ (V <sub>SS</sub> )	84	
NCS (N.C.)	38	
ERROR (V <sub>CC</sub> )	87	
PDTMR	12	
NMI	85	
INT0	33	
INT1	34	
INT2	35	
INT3	36	
INT4	43	
INT5	44	
INT6	45	
INT7	46	

1/0			
Name	Pin		
UCS	91		
LCS	92		
P1.7/GCS7 P1.6/GCS6 P1.5/GCS5 P1.4/GCS4 P1.3/GCS3 P1.2/GCS2 P1.1/GCS1	93 94 95 96 97 98 99		
P1.0/GCS0  P2.7/CTS1 P2.6/BCLK1 P2.5/TXD1 P2.4/RXD1 P2.3/CTS0 P2.2/BCLK0 P2.1/TXD0 P2.0/RXD0	100 26 25 24 23 22 21 20 19		
P3.5 P3.4 P3.3/DMAI1 P3.2/DMAI0 P3.1/TXI1 P3.0/RXI1	32 31 30 29 28 27		
TOIN TOOUT T1IN T1OUT	6 5 8 7		
DRQ0 DRQ1 DRQ2 DRQ3	1 2 3 4		
WDTOUT	39		



Table 6. QFP Package Location with Pin Names

Pin	Name
1	DRQ0
2	DRQ1
3	DRQ2
4	DRQ3
5	TOOUT
6	TOIN
7	T1OUT
8	T1IN
9	CLKOUT
10	RESOUT
11	RESIN
12	PDTMR
13	CLKIN
14	OSCOUT
15	V <sub>SS</sub>
16	Vcc
17	Vcc
18	V <sub>SS</sub>
19	P2.0/RXD0
20	P2.1/TXD0
21	P2.2/BCLK0
22	P2.3/CTS0
23	P2.4/RXD1
24	P2.5/TXD1
25	P2.6/BCLK1

Table 6. GFF Fackage Locatio			
Pin	Name		Pin
26	P2.7/CTS1		51
27	P3.0/RXI1		52
28	P3.1/TXI1		53
29	DMAI0/P3.2		54
30	DMAI1/P3.3		55
31	P3.4		56
32	P3.5		57
33	INT0		58
34	INT1		59
35	INT2		60
36	INT3		61
37	ÎNTA		62
38	NCS (N.C.)		63
39	WDTOUT		64
40	V <sub>SS</sub>		65
41	V <sub>CC</sub>		66
42	V <sub>SS</sub>		67
43	INT4		68
44	INT5		69
45	INT6		70
46	INT7		71
47	HOLD		72
48	HLDA		73
49	DT/R		74
50	DEN		75

•	ocation with Fin Names			
	Pin	Name		
	51	LOCK		
	52	WR		
	53	RD		
	54	BHE (RFSH)		
	55	ALE		
	56	AD15 (A15)		
	57	AD14 (A14)		
	58	AD13 (A13)		
	59	AD12 (A12)		
	60	AD11 (A11)		
ı	61	AD10 (A10)		
	62	AD9 (A9)		
	63	AD8 (A8)		
	64	$V_{SS}$		
	65	V <sub>CC</sub>		
	66	AD7		
	67	AD6		
	68	AD5		
	69	AD4		
	70	Vcc		
-	71	V <sub>SS</sub>		
	72 70	Vcc		
	73	AD3		
	74	AD2		
ı	75	AD1		

	Pin	Name
	76	AD0
	77	A19/S6/ONCE
	78	A18/S5
	79	A17/S4
	80	A16/S3
	81	<u>50</u>
	82	<u>S1</u>
	83	<u>52</u>
	84	PEREQ (V <sub>SS</sub> )
	85	NMI
	86	TEST
	87	ERROR (V <sub>CC</sub> )
	88	READY
	89	Vcc
	90	$v_{ss}$
	91	UCS
	92	LCS
	93	P1.7/GCS7
	94	P1.6/GCS6
	95	P1.5/GCS5
	96	P1.4/GCS4
	97	P1.3/GCS3
	98	P1.2/GCS2
	99	P1.1/GCS1
l	100	P1.0/GCS0



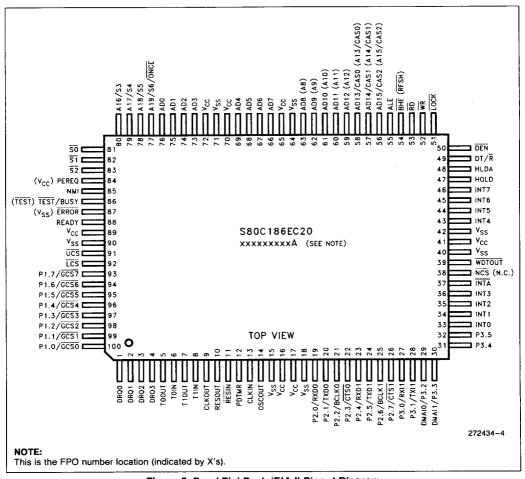


Figure 5. Quad Flat Pack (EIAJ) Pinout Diagram



**Table 7. SQFP Pin Functions with Location** 

AD Bus		
AD0	73	
AD1	72	
AD2	71	
AD3	70	
AD4	66	
AD5	65	
AD6	64	
AD7	63	
AD8 (A8)	60	
AD9 (A9)	59	
AD10 (A10)	58	
AD11 (A11)	57	
AD12 (A12)	56	
AD13 (A13)	55	
AD14 (A14)	54	
AD15 (A15)	53	
A16	77	
A17	76	
A18	75	
A19/ONCE	74	

Bus Control		
ALE	52	
BHE (RFSH)	51	
<del>\$0</del>	78	
<del>S</del> 1	79	
<u>\$2</u>	80	
RD	50	
WR .	49	
READY	85	
DT/R	46	
DEN	47	
<b>LOCK</b>	48	
HOLD	44	
HLDA	45	

Processor Control		
RESIN	8	
RESOUT	7	
CLKIN	10	
OSCOUT	11	
CLKOUT	6	
TEST/BUSY	83	
NMI	82	
INT0	30	
INT1	31	
INT2	32	
INT3	33	
INT4	40	
INT5	41	
INT6	42	
INT7	43	
INTA	34	
PEREQ (V <sub>SS</sub> )	81	
ERROR (V <sub>CC</sub> )	84	
NCS (N.C.)	35	
PDTMR	9	

Power and Ground		
Vcc	13	
Vcc	14	
Vcc	38	
Vcc	62	
V <sub>CC</sub>	67	
Vcc	69	
Vcc	86	
Vss	12	
V <sub>SS</sub>	15	
V <sub>SS</sub>	37	
V <sub>SS</sub>	39	
V <sub>SS</sub>	61	
Vss	68	
V <sub>SS</sub>	87	

1/0	
UCS	88
<u>LCS</u>	89
P1.0/GCS0 P1.1/GCS1 P1.2/GCS2 P1.3/GCS3 P1.4/GCS4 P1.5/GCS5 P1.6/GCS6 P1.7/GCS7	97 96 95 94 93 92 91
P2.0/RXD0 P2.1/TXD0	16 17
P2.2/BCLK0	18
P2.3/CTS0	19
P2.4/RXD1	20
P2.5/TXD1	21
P2.6/BCLK1	22
P2.7/CTS1	23
P3.0/RXI1	24

P3.0/RXI1	24
P3.1/TXI1	25
P3.2/DMAI0	26
P3.3/DMAI1	27
P3.4	28
P3.5	29
DRQ0	98
DRQ1	99
DRQ2	100
DRQ3	1
TOIN	3
T0OUT	2
T1IN	5
T1OUT	4
WDTOUT	36



**Table 8. SQFP Pin Locations with Pin Names** 

Pin	Name		Pin	Name
1	DRQ3		26	P3.2/DMAI0
2	TOOUT	ļ	27	P3.3/DMAI1
3	TOIN		28	P3.4
4	T1OUT		29	P3.5
5	TIIN		30	INTO
6	CLKOUT		31	INT1
7	RESOUT		32	INT2
8	RESIN		33	INT3
9	PDTMR		34	ĪNTA
10	CLKIN		35	NSC (N.C.)
11	OSCOUT		36	WDTOUT
12	$V_{SS}$		37	V <sub>SS</sub>
13	V <sub>CC</sub>		38	Vcc
14	V <sub>CC</sub>		39	V <sub>SS</sub>
15	V <sub>SS</sub>		40	INT4
16	P2.0/RXD0		41	INT5
17	P2.1/TXD0		42	INT6
18	P2.2/BCLK0		43	INT7
19	P2.3/CTS0		44	HOLD
20	P2.4/RXD1		45	HLDA
21	P2.5/TXD1		46	DT/R
22	P2.6/BCLK1		47	DEN
23	P2.7/CTS1		48	LOCK
24	P3.0/RXI1		49	WR
25	P3.1/TXI1		50	RD .

а	tions wi	ith Pin Names
	Pin	Name
	51	BHE (RFSH)
	52	ALE
	53	AD15 (A15)
	54	AD14 (A14)
	55	AD13 (A13)
	56	AD12 (A12)
	57	AD11 (A11)
	58	AD10 (A10)
	59	AD9 (A9)
	60	AD8 (A8)
	61	V <sub>SS</sub>
	62	Vcc
	63	AD7 (A7)
	64	AD6 (A6)
	65	AD5
	66	AD4
	67	V <sub>CC</sub>
	68	$V_{SS}$
	69	V <sub>CC</sub>
	70	AD3
	71	AD2
	72	AD1
	73	AD0
	74	A19/ONCE
	75	AD18

Pin	Name
76	A17
77	A16
78	<u>\$0</u>
79	<u>S1</u>
80	<u>\$2</u>
81	PEREQ (V <sub>SS</sub> )
82	MNI
83	TEST/BUSY
	(TEST)
84	ERROR (V <sub>CC</sub> )
85	READY
86	V <sub>CC</sub>
87	V <sub>SS</sub>
88	UCS
89	LCS
90	P1.7/GCS7
91	P1.6/GS6
92	P1.5/GCS5
93	P1.4/GCS4
94	P1.3/GCS3
95	P1.2/GCS2
96	P1.1/GCS1
97	P1.0/GCS0
98	DRQ0
99	DRQ1
100	DRQ2



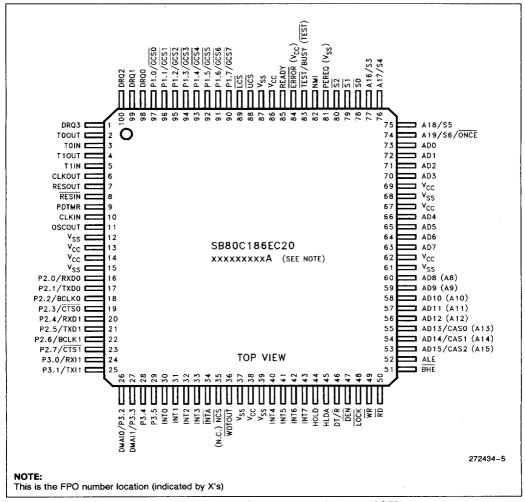


Figure 6. 100-Pin Shrink Quad Flat Pack Package (SQFP)



#### **Package Thermal Specifications**

The 80C186EC/80L186EC is specified for operation when  $T_C$  (the case temperature) is within the range of  $-40^{\circ}$ C to  $+100^{\circ}$ C.  $T_C$  may be measured in any environment to determine whether the processor is within the specified operating range. The case temperature must be measured at the center of the top surface.

 $T_A$  (the ambient temperature) can be calculated from  $\theta_{CA}$  (thermal resistance from the case to ambient) with the following equation:

$$T_A = T_C - P * \theta_{CA}$$

Typical values for  $\theta_{CA}$  at various airflows are given in Table 9. P (the maximum power consumption—specified in Watts) is calculated by using the maximum I<sub>CC</sub> and V<sub>CC</sub> of 5.5V.

Table 9. Thermal Resistance ( $\theta_{CA}$ ) at Various Airflows (in °C/Watt)

	Airflow in ft/min (m/sec)						
	0 (0)	200 (1.01)	400 (2.03)	600 (3.04)	800 (4.06)	1000 (5.07)	
θ <sub>CA</sub> (PQFP)	27.0	22.0	18.0	15.0	14.0	13.5	
$\theta_{CA}$ (QFP)	64.5	55.5	51.0	TBD	TBD	TBD	
$\theta_{CA}$ (SQFP)	62.0	TBD	TBD	TBD	TBD	TBD	



#### **ELECTRICAL SPECIFICATIONS**

#### **Absolute Maximum Ratings**

Storage Temperature 65°C to + 150°C
Case Temperature Under Bias $-65^{\circ}$ C to $+100^{\circ}$ C
Supply Voltage with Respect to $V_{SS}$ $-0.5V$ to $+6.5V$
Voltage on Other Pins with Respect to $V_{SS}$ $-0.5V$ to $V_{CC}$ + 0.5V

#### **Recommended Connections**

Power and ground connections must be made to multiple  $V_{CC}$  and  $V_{SS}$  pins. Every 80C186EC-based circuit board should include separate power ( $V_{CC}$ ) and ground ( $V_{SS}$ ) planes. Every  $V_{CC}$  pin must be connected to the power plane, and every  $V_{SS}$  pin must be connected to the ground plane. Liberal decoupling capacitance should be placed near the processor. The processor can cause transient power surges when its output buffers transition, particularly when connected to large capacitive loads.

NOTICE: This data sheet contains preliminary information on new products in production. The specifications are subject to change without notice. Verify with your local Intel Sales office that you have the latest data sheet before finalizing a design.

\*WARNING: Stressing the device beyond the "Absolute Maximum Ratings" may cause permanent damage. These are stress ratings only. Operation beyond the "Operating Conditions" is not recommended and extended exposure beyond the "Operating Conditions" may affect device reliability.

Low inductance capacitors and interconnects are recommended for best high frequency electrical performance. Inductance is reduced by placing the decoupling capacitors as close as possible to the processor V<sub>CC</sub> and V<sub>SS</sub> package pins.

Always connect any unused input to an appropriate signal level. In particular, unused interrupt inputs (NMI, INT0:7) should be connected to V<sub>SS</sub> through a pull-down resistor. Leave any unused output pin unconnected.



#### DC SPECIFICATIONS (80C186EC/80C188EC)

Symbol	Parameter	Min	Max	Units	Notes
Vcc	Supply Voltage	4.5	5.5	V	
V <sub>IL</sub>	Input Low Voltage	-0.5	0.3 V <sub>CC</sub>	V	
V <sub>IH</sub>	Input High Voltage	0.7 V <sub>CC</sub>	V <sub>CC</sub> + 0.5	V	
V <sub>OL</sub>	Output Low Voltage		0.45	V	I <sub>OL</sub> = 3 mA (Min)
VoH	Output High Voltage	V <sub>CC</sub> - 0.5		V	$I_{OH} = -2 \text{ mA (Min)}$
V <sub>HYR</sub>	Input Hysteresis on RESIN	0.5		V	
lu	Input Leakage Current for Pins: AD15:0 (AD7:0, A15:8), READY, HOLD, RESIN, CLKIN, TEST/BUSY, NMI, INT7:0, TOIN, T1IN, P2.7-P2.0, P3.5-P3.0, DRQ3:0, PEREQ, ERROR		±15	μΑ	0 ≤ V <sub>IN</sub> ≤ V <sub>CC</sub>
I <sub>LIU</sub>	Input Leakage for Pins with Pullups Active During Reset: A19:16, LOCK	-0.275	-5	mA	V <sub>IN</sub> = 0.7 V <sub>CC</sub> (Note 1)
lro	Output Leakage for Floated Output Pins		±15	μΑ	$0.45 \le V_{OUT} \le V_{CC}$ (Note 2)
Icc	Supply Current Cold (in RESET) 80C186EC25 80C186EC20 80C186EC13		125 100 70	mA mA mA	(Notes 3, 7) (Note 3) (Note 3)
l <sub>ID</sub>	Supply Current in Idle Mode 80C186EC25 80C186EC20 80C186EC13		92 76 50	mA mA mA	(Notes 4, 7) (Note 4) (Note 4)
I <sub>PD</sub>	Supply Current in Powerdown Mode 80C186EC25 80C186EC20 80C186EC13		100 100 100	μΑ μΑ μΑ	(Notes 5, 7) (Note 5) (Note 5)
C <sub>IN</sub>	Input Pin Capacitance	0	15	pF	T <sub>F</sub> = 1 MHz
C <sub>OUT</sub>	Output Pin Capacitance	0	15	рF	T <sub>F</sub> = 1 MHz (Note 6)

#### NOTES:

- 1. These pins have an internal pull-up device that is active while RESIN is low and ONCE Mode is not active. Sourcing more current than specified (on any of these pins) may invoke a factory test mode.
- 2. Tested by outputs being floated by invoking ONCE Mode or by asserting HOLD.
- Measured with the device in RESET and at worst case frequency, V<sub>CC</sub>, and temperature with ALL outputs loaded as specified in AC Test Conditions, and all floating outputs driven to V<sub>CC</sub> or GND.
- 4. Measured with the device in HALT (IDLE Mode active) and at worst case frequency, V<sub>CC</sub>, and temperature with ALL outputs loaded as specified in AC Test Conditions, and all floating outputs driven to V<sub>CC</sub> or GND.
- Measured with the device in HALT (Powerdown Mode active) and at worst case frequency, V<sub>CC</sub>, and temperature with ALL outputs loaded as specified in AC Test Conditions, and all floating outputs driven to V<sub>CC</sub> or GND.
- 6. Output Capacitance is the capacitive load of a floating output pin.
- 7. Operating conditions for 25 MHz is 0°C to +70°C,  $V_{CC} = 5.0 \pm 10$ %.

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#### DC SPECIFICATIONS (80L186EC/80L188EC)

Symbol	Parameter	Min	Max	Units	Notes
V <sub>CC</sub>	Supply Voltage	2.7	5.5	٧	
V <sub>IL</sub>	Input Low Voltage	-0.5	0.3 V <sub>CC</sub>	٧	
V <sub>IH</sub>	Input High Voltage	0.7 V <sub>CC</sub>	V <sub>CC</sub> + 0.5	٧	
V <sub>OL</sub>	Output Low Voltage		0.45	٧	$I_{OL} = 3 \text{ mA (Min)}$
Voн	Output High Voltage	V <sub>CC</sub> - 0.5		V	I <sub>OH</sub> = -2 mA (Min)
V <sub>HYR</sub>	Input Hysteresis on RESIN	0.5		٧	
I <sub>L1</sub>	Input Leakage Current for Pins: AD15:0 (AD7:0, A15:8), READY, HOLD, RESIN, CLKIN, TEST/BUSY, NMI, INT7:0, TOIN, T1IN, P2.7-P2.0, P3.5-P3.0, DRQ3:0, PEREQ, ERROR		±15	μΑ	0 ≤ V <sub>IN</sub> ≤ V <sub>CC</sub>
lLIU	Input Leakage for Pins with Pullups Active During Reset: A19:16, LOCK	-0.275	-5	mA	V <sub>IN</sub> = 0.7 V <sub>CC</sub> (Note 1)
ILO	Output Leakage for Floated Output Pins		±15	μА	0.45 ≤ V <sub>OUT</sub> ≤ V <sub>CC</sub> (Note 2)
Icc	Supply Current Cold (in RESET) 80L186EC-13		36	mA	(Note 3)
I <sub>ID</sub>	Supply Current in Idle Mode 80L186EC-13		24	mA	(Note 4)
I <sub>PD</sub>	Supply Current in Powerdown Mode 80L186EC-13		30	μА	(Note 5)
C <sub>IN</sub>	Input Pin Capacitance	0	15	pF	T <sub>F</sub> = 1 MHz
C <sub>OUT</sub>	Output Pin Capacitance	0	15	рF	T <sub>F</sub> = 1 MHz (Note 6)

#### NOTES:

- 1. These pins have an internal pull-up device that is active while RESIN is low and ONCE Mode is not active. Sourcing more current than specified (on any of these pins) may invoke a factory test mode.
- 2. Tested by outputs being floated by invoking ONCE Mode or by asserting HOLD.
- Measured with the device in RESET and at worst case frequency, V<sub>CC</sub>, and temperature with ALL outputs loaded as specified in AC Test Conditions, and all floating outputs driven to V<sub>CC</sub> or GND.
- 4. Measured with the device in HALT (IDLE Mode active) and at worst case frequency, V<sub>CC</sub>, and temperature with ALL outputs loaded as specified in AC Test Conditions, and all floating outputs driven to V<sub>CC</sub> or GND.
- 5. Measured with the device in HALT (Powerdown Mode active) and at worst case frequency, V<sub>CC</sub>, and temperature with ALL outputs loaded as specified in AC Test Conditions, and all floating outputs driven to V<sub>CC</sub> or GND.
- 6. Output Capacitance is the capacitive load of a floating output pin.



#### I<sub>CC</sub> versus Frequency and Voltage

The  $I_{CC}$  consumed by the processor is composed of two components:

- I<sub>PD</sub>—The quiescent current that represents internal device leakage. Measured with all inputs at either V<sub>CC</sub> or ground and no clock applied.
- I<sub>CCS</sub>—The switching current used to charge and discharge internal parasitic capacitance when changing logic levels. I<sub>CCS</sub> is related to both the frequency of operation and the device supply voltage (V<sub>CC</sub>). I<sub>CCS</sub> is given by the formula:

Power = 
$$V * I = V^2 * C_{DEV} * f$$
  
 $\therefore I_{CCS} = V * C_{DEV} * f$ 

#### Where:

V = Supply Voltage (V<sub>CC</sub>)

C<sub>DEV</sub> = Device Capacitance
f = Operating Frequency

Measuring  $C_{PD}$  on a device like the 80C186EC would be difficult. Instead,  $C_{PD}$  is calculated using the above formula with  $I_{CC}$  values measured at known  $V_{CC}$  and frequency. Using the  $C_{PD}$  value, the user can calculate  $I_{CC}$  at any voltage and frequency within the specified operating range.

Example. Calculate typical I<sub>CC</sub> at 14 MHz, 5.2V V<sub>CC</sub>.

#### PDTMR Pin Delay Calculation

The PDTMR pin provides a delay between the assertion of NMI and the enabling of the internal clocks when exiting Powerdown Mode. A delay is required only when using the on chip oscillator to allow the crystal or resonator circuit to stabilize.

#### NOTE:

The PDTMR pin function does not apply when RESIN is asserted (i.e. a device reset while in Powerdown is similar to a cold reset and RESIN must remain active until after the oscillator has stabilized.

To calculate the value of capacitor to use to provide a desired delay, use the equation:

$$440 \times t = C_{PD} (5V, 25^{\circ}C)$$

#### Where:

t= desired delay in **seconds**  $C_{PD}=$  capacitive load on PDTMR in **microfarads** 

**Example.** For a delay of 300  $\mu$ s, a capacitor value of C<sub>PD</sub> = 440  $\times$  (300  $\times$  10<sup>-6</sup> = 0.132  $\mu$ F is required. Round up to a standard (available) capacitor value.

#### NOTE:

The above equation applies to delay time longer than 10  $\mu s$  and will compute the **TYPICAL** capacitance needed to achieve the desired delay. A delay variance of +50% to -25% can occur due to temperature, voltage, and device process extremes. In general, higher  $V_{CC}$  and/or lower temperatures will decrease delay time, while lower  $V_{CC}$  and/or higher temperature will increase delay time.

Parameter	Typical	Max	Units	Notes
CPD	0.77	1.37	mA/V*MHz	1, 2
CPD (Idle Mode)	0.55	0.96	mA/V*MHz	1, 2

#### NOTES:

1. Maximum  $C_{PD}$  is measured at  $-40^{\circ}$ C with all outputs loaded as specified in the AC test conditions and the device in reset (or Idle Mode). Due to tester limitations, CLKOUT and OSCOUT also have 50 pF loads that increase  $I_{CC}$  by V\*C\*F.

2. Typical CPD is calculated at 25°C assuming no loads on CLKOUT or OSCOUT and the device in reset (or Idle Mode).



#### **AC SPECIFICATIONS**

#### AC Characteristics—80C186EC25

Symbol	Parameter -	25	MHz	l lmian	
Symbol	Parameter	Min	Max	Units	Notes
INPUT C	LOCK				
Τ <sub>F</sub>	CLKIN Frequency	0	50	MHz	1
TC	CLKIN Period	20	∞	ns	1
TCH	CLKIN High Time	8	∞	ns	1, 2
T <sub>CL</sub>	CLKIN Low Time	8	∞ ∞	ns	1, 2
TCR	CLKIN Rise Time	1	10	ns	1,3
T <sub>CF</sub>	CLKIN Fall Time	1	10	ns	1, 3
OUTPUT	CLOCK				
T <sub>CD</sub>	CLKIN to CLKOUT Delay	0	17	ns	1, 4
T	CLKOUT Period		2*T <sub>C</sub>	ns	1
T <sub>PH</sub>	CLKOUT High Time	(T/2) - 5	(T/2) + 5	ns	1
TPL	CLKOUT Low Time	(T/2) - 5	(T/2) + 5	ns	1
TPR	CLKOUT Rise Time	1	6	ns	1, 5
T <sub>PF</sub>	CLKOUT Fall Time	1	6	ns	1, 5
OUTPUT	DELAYS				
T <sub>CHOV1</sub>	ALE, \$2:0, DEN, DT/R, BHE (RFSH), LOCK, A19:16	3	17	ns	1, 4, 6, 7
T <sub>CHOV2</sub>	GCS0:7, LCS, UCS, NCS, RD, WR	3	20	ns	1, 4, 6, 8
T <sub>CLOV1</sub>	BHÉ (RFSH), DEN, LOCK, RESOUT, HLDA, TOOUT, T1OUT, A19:16	3	17	ns	1, 4, 6
T <sub>CLOV2</sub>	RD, WR, GCS7:0, LCS, UCS, AD15:0 (AD7:0, A15:8), NCS, INTA1:0, S2:0	3	20	ns	1, 4, 6
T <sub>CHOF</sub>	RD, WR, BHE (RFSH), DT/R, LOCK, S2:0, A19:16	0	20	ns	1
TCLOF	DEN, AD15:0 (AD7:0, A15:8)	0	20	ns	1



#### **AC SPECIFICATIONS**

#### AC Characteristics—80C186EC25 (Continued)

Symbol	Parameter		25 MHz		
	Parameter	Min	Max	Units	Notes
SYNCHR	ONOUS INPUTS				
T <sub>CHIS</sub>	TEST, NMI, INT4:0, BCLK1:0, T1:0IN, READY, CTS1:0, P2.6, P2.7	10		ns	1, 9
T <sub>CHIH</sub>	TEST, NMI, INT4:0, BCLK1:0, T1:0IN, READY, CTS1:0	3		ns	1, 9
T <sub>CLIS</sub>	AD15:0 (AD7:0), READY	10		ns	1, 10
T <sub>CLIH</sub>	READY, AD15:0 (AD7:0)	3		ns	1, 10
T <sub>CLIS</sub>	HOLD, PEREQ, ERROR	10		ns	1, 9
T <sub>CLIH</sub>	HOLD, PEREQ, ERROR	3		ns	1, 9

- 1. See AC Timing Waveforms, for waveforms and definition.
- 2. Measure at VIH for high time, VIL for low time.
- 3. Only required to guarantee ICC. Maximum limits are bounded by TC, TCH and TCL.
- 4. Specified for a 50 pF load, see Figure 13 for capacitive derating information.
- 5. Specified for a 50 pF load, see Figure 14 for rise and fall times outside 50 pF.
- 6. See Figure 14 for rise and fall times
- 7. T<sub>CHOV1</sub> applies to BHE (RFSH), LOCK and A19:16 only after a HOLD release.
- 8. TCHOV2 applies to RD and WR only after a HOLD release.
- 9. Setup and Hold are required to guarantee recognition.
- 10. Setup and Hold are required for proper operation.



#### **AC SPECIFICATIONS**

#### AC Characteristics—80C186EC-20/80C186EC-13

Symbol	Parameter	Min	Max	Min	Max	Unit	Notes
INPUT C	CLOCK	20	MHz	13 I	VIHz		
TF TC	CLKIN Frequency CLKIN Period	0 25	40 ∞	0 38.5	26 ∞	MHz ns	1
	CLKIN High Time CLKIN Low Time	10 10	∞ ∞	12 12	∞ ∞	ns ns	1, 2 1, 2
TCR TCF	CLKIN Rise Time CLKIN Fall Time	.1	10 10	1	10 10	ns ns	1, 3 1, 3
OUTPU	OUTPUT CLOCK						
T <sub>CD</sub> T	CLKIN to CLKOUT Delay CLKOUT Period	0	17 2 * TC	0	23 2 * TC	ns ns	1, 4 1
T <sub>PH</sub> T <sub>PL</sub>	CLKOUT High Time CLKOUT Low Time	(T/2) - 5	(T/2) + 5 (T/2) + 5		(T/2) + 5	ns ns	1
T <sub>PR</sub> T <sub>PF</sub>	CLKOUT Rise Time CLKOUT Fall Time	1	6 6	1	6 6	ns ns	1, 5 1, 5
OUTPU	T DELAYS						
T <sub>CHOV1</sub>	ALE, <u>\$2:0, DEN, DT/R,</u> BHE (RFSH), LOCK, A19:16	3	20	3	25	ns	1, 4, 6, 7
T <sub>CHOV2</sub>	GCS7:0, LCS, UCS, RD, WR, NCS, WDTOUT	3	23	3	30	กร	1, 4, 6, 8
T <sub>CLOV1</sub>	BHE (RFSH), DEN, LOCK, RESOUT, HLDA, TOOUT, T1OUT	3	20	3	25	ns	1, 4, 6
T <sub>CLOV2</sub>	RD, WR, GSC7:0, LCS, UCS, AD15:0 (AD7:0, A15:8), NCS, INTA, S2:0, A19:16	3	23	3	30	ns	1, 4, 6
T <sub>CHOF</sub>	RD, WR, BHE (RFSH), DT/R, LOCK, S2:0, A19:16	0	25	0	30	ns	1
T <sub>CLOF</sub>	DEN, AD15:0 (AD7:0, A15:8)	0	25	0	30	ns	1
INPUT F	REQUIREMENTS						
T <sub>CHIS</sub>	TEST, NMI, T1IN, T0IN, READY, CTS1:0, BCLK1:0, P3.4, P3.5	10		10		ns	1, 9
T <sub>CHIH</sub>	TEST, NMI, T1IN, T0IN, READY, CTS1:0, BCLK1:0, P3.4, P3.5	3		3		ns	1, 9
T <sub>CLIS</sub>	AD15:0 (AD7:0), READY	10		10		ns	1, 10
TCLIH	AD15:0 (AD7:0), READY	3		3		ns	1, 10
T <sub>CLIS</sub>	HOLD, RESIN, PEREQ, ERROR, DRQ3:0	10		10		ns	1, 9
TCLIH	HOLD, RESIN, REREQ, ERROR, DRQ3:0	3		3		ns	1, 9

- 1. See AC Timing Waveforms, for waveforms and definition.
- 2. Measure at VIH for high time, VIL for low time.
- 3. Only required to guarantee I<sub>CC</sub>. Maximum limits are bounded by T<sub>C</sub>, T<sub>CH</sub> and T<sub>CL</sub>.

  4. Specified for a 50 pF load, see Figure 14 for capacitive derating information.

  5. Specified for a 50 pF load, see Figure 15 for rise and fall times outside 50 pF.

- 6. See Figure 15 for rise and fall times.
- 7. T<sub>CHOV1</sub> applies to BHE (RFSH), LOCK and A19:16 only after a HOLD release.
- 8. T<sub>CHOV2</sub> applies to  $\overline{\text{RD}}$  and  $\overline{\text{WR}}$  only after a HOLD release.
- 9. Setup and Hold are required to guarantee recognition.
- Setup and Hold are required for proper operation.

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#### AC Characteristics—80L186EC13

Symbol	Parameter	Min	Max	Unit	Notes
INPUT CL	OCK	13	MHz		
TF	CLKIN Frequency	0	26	MHz	1
TC	CLKIN Period	38.5	∞	ns	1
TCH	CLKIN High Time	15	∞	ns	1, 2
TCL	CLKIN Low Time	15	∞0	ns	1, 2
TCR TCF	CLKIN Rise Time CLKIN Fall Time	1 1	10	ns	1, 3
OUTPUT		1	10	ns	1, 3
			· · · · · · · · · · · · · · · · · · ·	r	
T <sub>CD</sub>	CLKIN to CLKOUT Delay	0	20	ns	1, 4
T	CLKOUT Period	(T (0) 5	2 * TC	ns	1
T <sub>PH</sub> T <sub>PL</sub>	CLKOUT High Time CLKOUT Low Time	(T/2) - 5	(T/2) + 5	ns	1
'PL T <sub>PR</sub>	CLKOUT Rise Time	(T/2) - 5 1	(T/2) + 5	ns	1
T <sub>PF</sub>	CLKOUT Fall Time		10 10	ns ns	1,5 1,5
OUTPUT		J	10	115	1,5
T <sub>CHOV1</sub>	\$2:0, DT/R, BHE, LOCK	3	28		1 4 6 7
				ns	1, 4, 6, 7
T <sub>CHOV2</sub>	LCS, UCS, DEN, A19:16, RD, WR, NCS, WDTOUT, ALE	3	32	ns	1, 4, 6, 8
Тсноиз	GCS7:0	3	34	ns	1, 4, 6
T <sub>CLOV1</sub>	LOCK, RESOUT, HLDA, TOOUT, T1OUT	3	28	ns	1, 4, 6
T <sub>CLOV2</sub>	RD, WR, AD15:0 (AD7:0, A15:8), BHE (RFSH), NCS, INTA, DEN	3	32	ns	1, 4, 6
T <sub>CLOV3</sub>	GSC7:0, LCS, UCS	3	34	ns	1, 4, 6
T <sub>CLOV4</sub>	\$2:0, A19:16	3	37	ns	1, 4, 6
T <sub>CHOF</sub>	RD, WR, BHE (RFSH), DT/R, LOCK, S2:0, A19:16	0	30	ns	1
T <sub>CLOF</sub>	DEN, AD15:0 (AD7:0, A15:8)	0	35	ns	1
INPUT RE	QUIREMENTS				
T <sub>CHIS</sub>	TEST, NMI, T1IN, T0IN, READY, CTS1:0, BCLK1:0, P3.4, P3.5	20		ns	1, 9
T <sub>CHIH</sub>	TEST, NMI, T1IN, T0IN, READY, CTS1:0, BCLK1:0, P3.4, P3.5	3		ns	1, 9
T <sub>CLIS</sub>	AD15:0 (AD7:0), READY	20	****	ns	1, 10
T <sub>CLIH</sub>	AD15:0 (AD7:0), READY	3		ns	1, 10
T <sub>CLIS</sub>	HOLD, RESIN, PEREQ, ERROR, DRQ3:0	20		ns	1, 9
T <sub>CLIH</sub>	HOLD, RESIN, REREQ, ERROR, DRQ3:0	3		ns	1, 9

#### NOTES:

- 1. See AC Timing Waveforms, for waveforms and definition.
- Measure at V<sub>IH</sub> for high time, V<sub>IL</sub> for low time.
   Only required to guarantee I<sub>CC</sub>. Maximum limits are bounded by T<sub>C</sub>, T<sub>CH</sub> and T<sub>CL</sub>.
   Specified for a 50 pF load, see Figure 14 for capacitive derating information.
- 5. Specified for a 50 pF load, see Figure 15 for rise and fall times outside 50 pF.

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#### AC Characteristics—80L186EC (Continued)

#### NOTES:

6. See Figure 15 for rise and fall times.

- 7. T<sub>CHOV1</sub> applies to BHE (RFSH), LOCK and A19:16 only after a HOLD release.
- 8.  $T_{CHOV2}$  applies to  $\overline{RD}$  and  $\overline{WR}$  only after a HOLD release.
- 9. Setup and Hold are required to guarantee recognition.
- 10. Setup and Hold are required for proper operation.

#### Relative Timings (80C186EC-25/20/13, 80L186EC13)

Symbol	Parameter	Min	Max	Unit	Notes		
RELATIVE TIMINGS							
T <sub>LHLL</sub>	ALE Active Pulse Width	T — 15		ns			
T <sub>AVLL</sub>	AD Valid Setup before ALE Falls	½T - 10		ns			
T <sub>PLLL</sub>	Chip Select Valid before ALE Falls	½T – 10		ns	1		
T <sub>LLAX</sub>	AD Hold after ALE Falls	½T - 10		ns			
T <sub>LLWL</sub>	ALE Falling to WR Falling	1∕₂T − 15		ns	1		
T <sub>LLRL</sub>	ALE Falling to RD Falling	¹∕₂T − 15		ns	1		
T <sub>WHLH</sub>	WR Rising to Next ALE Rising	¹/₂T − 10		ns	1		
TAFRL	AD Float to RD Falling	0		ns			
T <sub>RLRH</sub>	RD Active Pulse Width	2T - 5		ns	2		
T <sub>WLWH</sub>	WR Active Pulse Width	2T - 5		ns	2		
TRHAX	RD Rising to Next Address Active	T — 15		ns			
T <sub>WHDX</sub>	Output Data Hold after WR Rising	T — 15		ns			
TWHPH	WR Rise to Chip Select Rise	½T – 10		ns	1		
T <sub>RHPH</sub>	RD Rise to Chip Select Rise	½T - 10		ns	1		
T <sub>PHPL</sub>	Chip Select Inactive to Next Chip Select Active	½T – 10		ns	1		
Tovrh	ONCE Active Setup to RESIN Rising	Т		ns			
T <sub>RHOX</sub>	ONCE Hold after RESIN Rise	Т		ns			
T <sub>IHIL</sub>	INTA High to Next INTA Low during INTA Cycle	4T — 5		ns	4		
T <sub>ILIH</sub>	INTA Active Pulse Width	2T - 5		ns	2, 4		
T <sub>CVIL</sub>	CAS2:0 Setup before 2nd ĪNTA Pulse Low	8T		ns	2, 4		

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#### Relative Timings (80C186EC-25/20/13, 80L186EC13) (Continued)

Symbol	Parameter	Min	Max	Unit	Notes
RELATIVE	TIMINGS				
T <sub>ILCX</sub>	CAS2:0 Hold after 2nd INTA Pulse Low	4T		ns	2, 4
T <sub>IRES</sub>	Interrupt Resolution Time		150	ns	3
TIRLH	IR Low Time to Reset Edge Detector	50		ns	-
TIRHIF	IR Hold Time after 1st INTA Falling	25		ns	4, 5

#### NOTES:

- 1. Assumes equal loading on both pins.
- 2. Can be extended using wait states.
- 3. Interrupt resolution time is the delay between an unmasked interrupt request going active and the interrupt output of the 8259A module going active. This is not directly measureable by the user. For interrupt pin INT7 the delay from an active signal to an active input to the CPU would actually be twice the T<sub>IRES</sub> value since the signal must pass through two 8259A modules.
- 4. See INTA Cycle Waveforms for definition.
- 5. To guarantee interrupt is not spurious.

### Serial Port Mode 0 Timings (80C186EC-25/20/13, 80L186EC13)

Symbol	Parameter	Min	Max	Unit	Notes				
RELATIVE TIMINGS									
T <sub>XLXL</sub>	TXD Clock Period	T (n + 1)		ns	1, 2				
T <sub>XLXH</sub>	TXD Clock Low to Clock High (N > 1)	2T — 35	2T + 35	ns	1				
T <sub>XLXH</sub>	TXD Clock Low to Clock High (N = 1)	T - 35	T + 35	ns	1				
T <sub>XHXL</sub>	TXD Clock High to Clock Low (N > 1)	(n - 1) T - 35	(n - 1) T + 35	ns	1, 2				
$T_{XHXL}$	TXD Clock High to Clock Low (N = 1)	T - 35	T + 35	ns	1				
T <sub>QVXH</sub>	RXD Output Data Setup to TXD Clock High (N > 1)	(n - 1)T - 35		ns	1, 2				
T <sub>QVXH</sub>	RXD Output Data Setup to TXD Clock High (N = 1)	T — 35	,	ns	1				
T <sub>XHQX</sub>	RXD Output Data Hold after TXD Clock High (N > 1)	2T — 35		ns	1				
T <sub>XHQX</sub>	RXD Output Data Hold after TXD Clock High (N = 1)	T — 35		ns	1				
T <sub>XHQZ</sub>	RXD Output Data Float after Last TXD Clock High		T + 20	ns	1				
T <sub>DVXH</sub>	RXD Input Data Setup to TXD Clock High	T + 20		ns	1				
T <sub>XHDX</sub>	RXD Input Data Setup after TXD Clock High	0		пѕ	1				

#### NOTES

- 1. See Figure 13 for Waveforms.
- 2. n is the value in the BxCMP register ignoring the ICLK bit.

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#### **AC TEST CONDITIONS**

The AC specifications are tested with the 50 pF load shown in Figure 7. See the Derating Curves section to see how timings vary with load capacitance.

Specifications are measured at the V<sub>CC</sub>/2 crossing point, unless otherwise specified. See AC Timing Waveforns for AC specification definitions, test pins and illustrations.

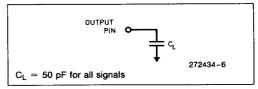


Figure 7. AC Test Load

#### **AC TIMING WAVEFORMS**

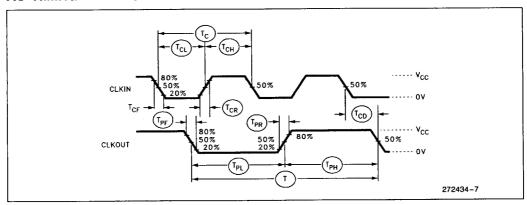


Figure 8. Input and Output Clock Waveforms



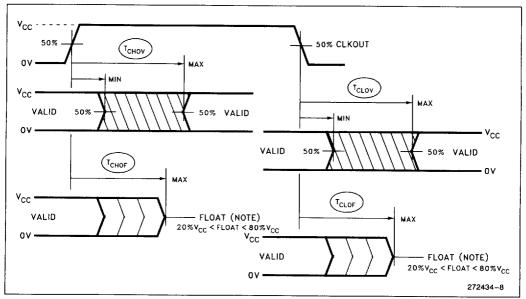


Figure 9. Output Delay and Float Waveforms

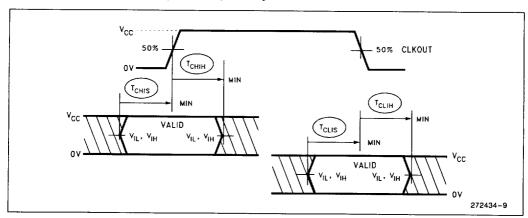


Figure 10. Input Setup and Hold

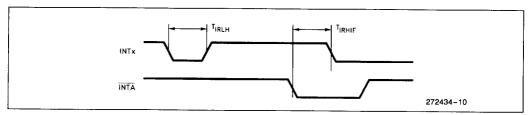


Figure 11. Relative Interrupt Signal Timings

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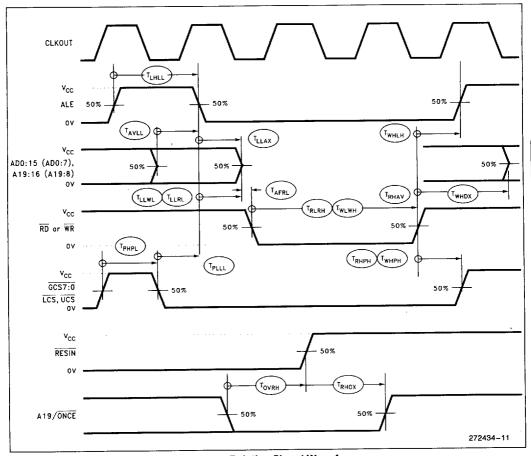


Figure 12. Relative Signal Waveform

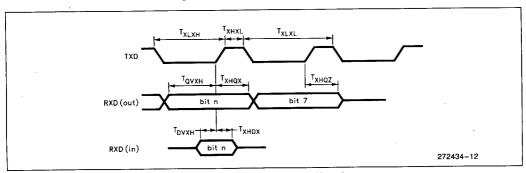


Figure 13. Serial Port Mode 0 Waveform



### **DERATING CURVES**

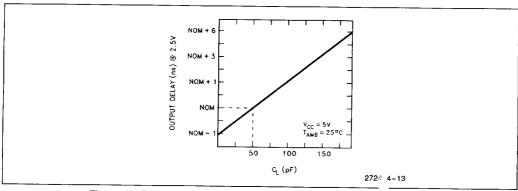


Figure 14. Typical Output Delay Variations versus Load Ca acitance

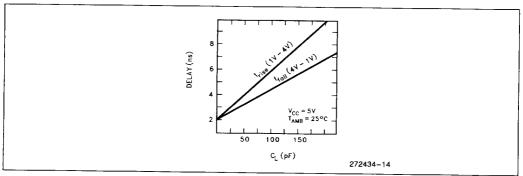


Figure 15. Typical Rise and Fall Variations versus Load Capacitance

## RESET

The processor will perform a reset operation any time the RESIN pin is active. The RESIN pin is synchronized before it is presented internally, which means that the clock must be operating before a reset can take effect. From a power-on state, RESIN must be held active (low) in order to guarantee correct initialization of the processor. Failure to provide RESIN while the device is powering up will result in unspecified operation of the device.

Figure 16 shows the correct reset sequence when first applying power to the processor. An external clock connected to CLKIN must not exceed the  $V_{\rm CC}$  threshold being applied to the processor. This is normally not a problem if the clock driver is supplied with the same  $V_{\rm CC}$  that supplies the processor. When attaching a crystal to the device,  $\overline{\rm RESIN}$  must remain active until both  $V_{\rm CC}$  and CLKOUT are stable (the length of time is application specific and depends on the startup characteristics of the crystal circuit). The  $\overline{\rm RESIN}$  pin is designed to operate cor-

rectly using a RC reset circuit, but the designer must ensure that the ramp time for  $V_{CC}$  is not so long that  $\overline{\text{RESIN}}$  is never sampled at a logic low level when  $V_{CC}$  reaches minimum operating conditions.

Figure 17 shows the timing sequence when  $\overline{\text{RESIN}}$  is applied after  $V_{CC}$  is stable and the device has been operating. Note that a reset will terminate all activity and return the processor to a known operating state. Any bus operation that is in progress at the time  $\overline{\text{RESIN}}$  is asserted will terminate immediately (note that most control signals will be driven to their inactive state first before floating).

While RESIN is active, bus signals LOCK, A19/S16/ONCE and A18:16 are configured as inputs and weakly held high by internal pullup transistors. Only A19/ONCE can be overdriven to a low and is used to enable the ONCE Mode. Forcing LOCK or A18:16 low at any time while RESIN is low is prohibited and will cause unspecified device operation.

1-228

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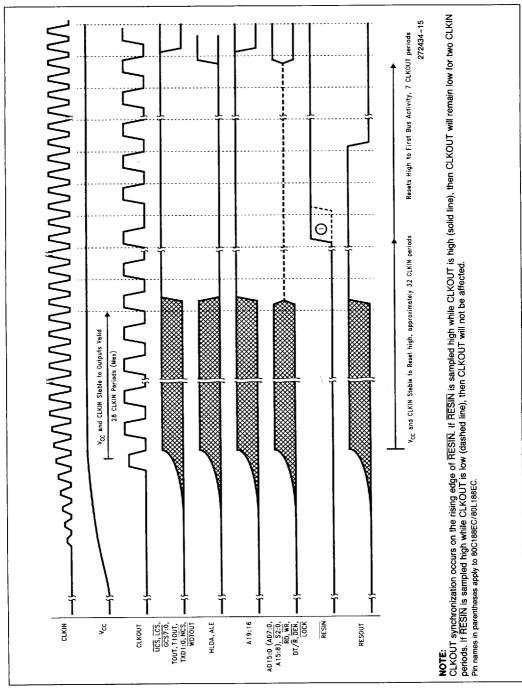


Figure 16. Cold RESET Waveforms

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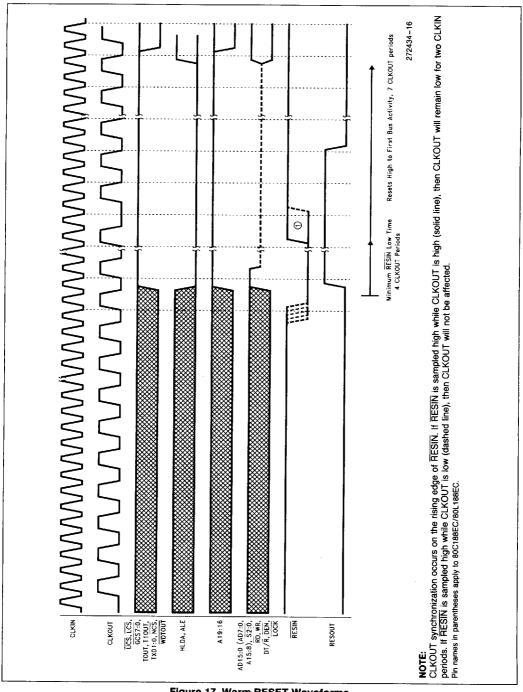


Figure 17. Warm RESET Waveforms

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# **BUS CYCLE WAVEFORMS**

Figures 18 through 24 present the various bus cycles that are generated by the processor. What is shown in the figure is the relationship of the various bus signals to CLKOUT. These figures along with the information present in AC Specifications allow the user to determine all the critical timing analysis needed for a given application.

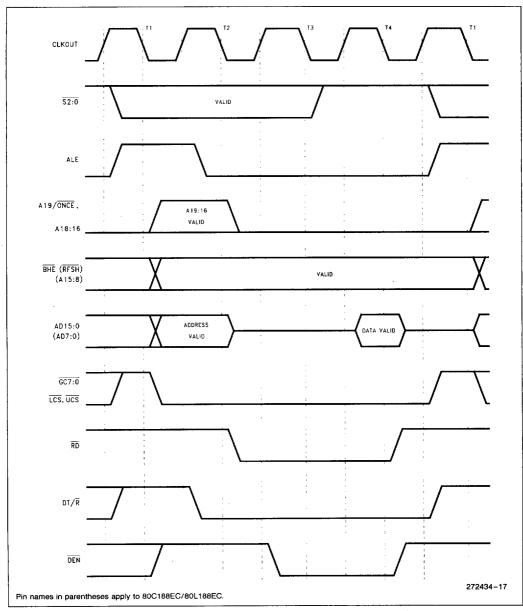


Figure 18. Memory Read, I/O Read, Instruction Fetch and Refresh Waveforms

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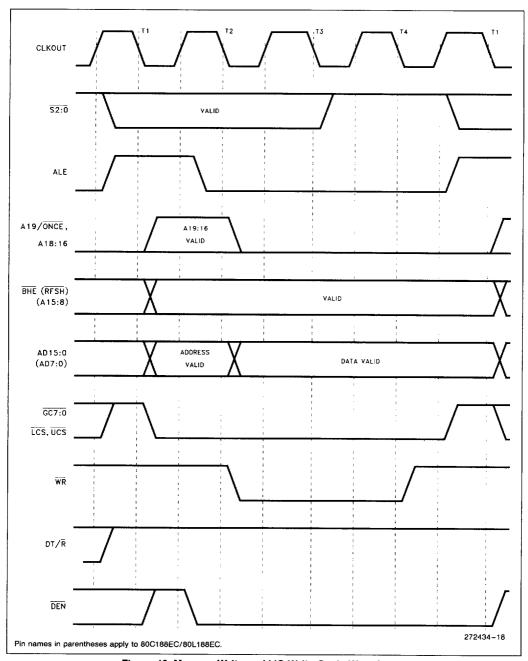
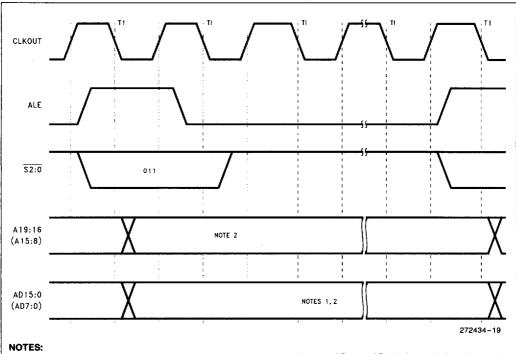


Figure 19. Memory Write and I/O Write Cycle Waveforms

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- 1. Address information is invalid. If previous bus cycle was a read, then the AD15:0 (AD7:0) lines will float during T1. Otherwise, the AD15:0 (AD7:0) lines will continue to drive during T1 (data is invalid). All other control lines are in their inactive state.
- 2. All address lines drive zeros while in Powerdown or Idle Mode.

Pin names in parentheses apply to 80C188EC/80L188EC.

Figure 20. Halt Cycle Waveforms



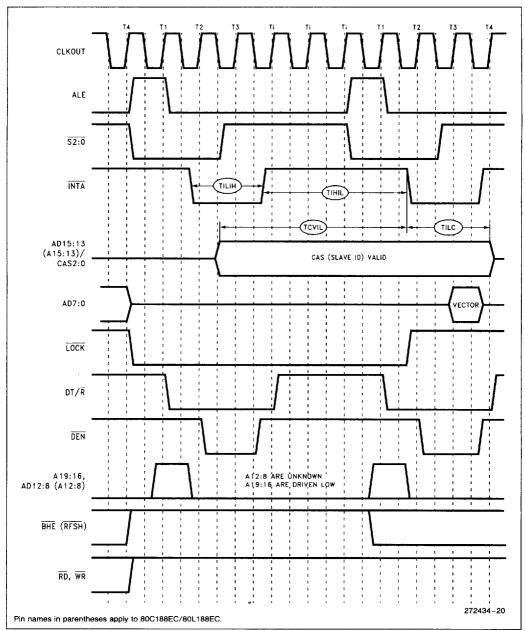


Figure 21. Interrupt Acknowledge Cycle Waveforms

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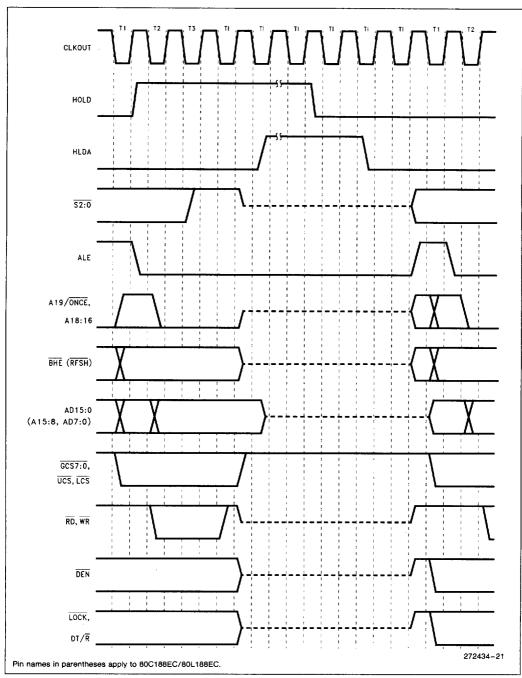


Figure 22. HOLD/HLDA Cycle Waveforms

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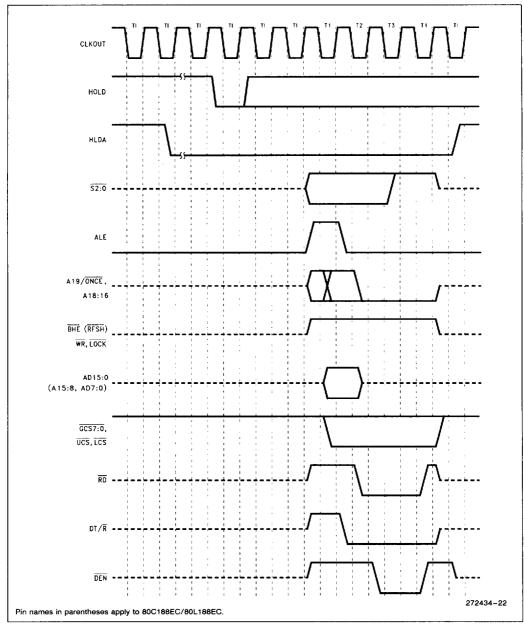


Figure 23. Refresh during HLDA Waveforms

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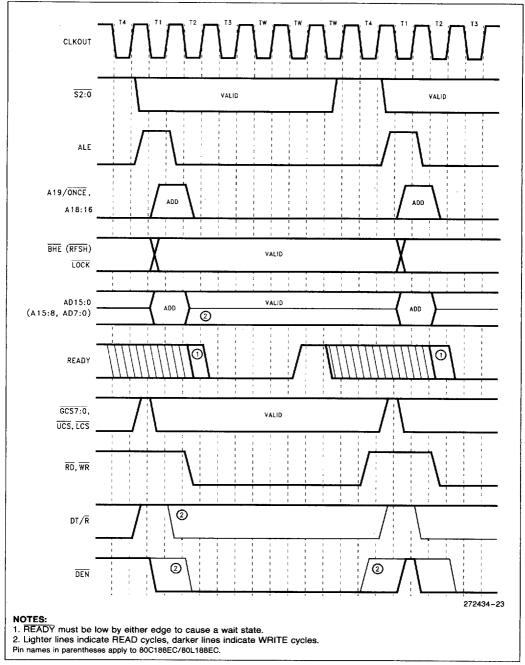


Figure 24. READY Cycle Waveforms

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# 80C186EC/80C188EC EXECUTION TIMINGS

A determination of program execution timing must consider the bus cycles necessary to prefetch instructions as well as the number of execution unit cycles necessary to execute instructions. The following instruction timings represent the **minimum** execution time in clock cycles for each instruction. The timings given are based on the following assumptions:

- The opcode, along with any data or displacement required for execution of a particular instruction, has been prefetched and resides in the queue at the time it is needed.
- · No wait states or bus HOLDs occur.
- All word-data is located on even-address boundaries (80C186EC only).

All jumps and calls include the time required to fetch the opcode of the next instruction at the destination address. All instructions which involve memory accesses can require one or two additional clocks above the minimum timings shown due to the asynchronous handshake between the bus interface unit (BIU) and execution unit.

With a 16-bit BIU, the 80C186EC has sufficient bus performance to ensure that an adequate number of prefetched bytes will reside in the queue (6 bytes) most of the time. Therefore, actual program execution time will not be substantially greater than that derived from adding the instruction timings shown.

The 80C188EC 8-bit BIU is limited in its performance relative to the execution unit. A sufficient number of prefetched bytes may not reside in the prefetch queue (4 bytes) much of the time. Therefore, actual program execution time will be substantially greater than that derived from adding the instruction timings shown



# INSTRUCTION SET SUMMARY

Function		Fo	ormat		80C186EC Clock Cycles	80C188EC Clock Cycles	Comments
DATA TRANSFER MOV = Move:			· · ·		Cycles	Cycles	
Register to Register/Memory	1000100w	mod reg r/m	]		2/12	2/12*	
Register/memory to register	1000101w	mod reg r/m			2/9	2/9*	
Immediate to register/memory	1100011w	mod 000 r/m	data	data if w = 1	12/13	12/13	8/16-bit
Immediate to register	1011w reg	data	data if w=1	]	3/4	3/4	8/16-bit
Memory to accumulator	1010000w	addr-low	addr-high	j	8	8*	
Accumulator to memory	1010001w	addr-low	addr-high	j	9	9*	
Register/memory to segment register	10001110	mod 0 reg r/m		•	2/9	2/13	
Segment register to register/memory	10001100	mod 0 reg r/m			2/11	2/15	
PUSH = Push:							
Memory	11111111	mod 1 1 0 r/m			16	. 20	
Register	0 1 0 1 0 reg				10	14	
Segment register	0 0 0 reg 1 1 0				9	13	
immediate	01101030	data	data if s=0		10		
kusia – sianai	01100000				96	68	
POP = Pop:							9 . 11 (** 11 11 11 11 11 11 11 11 11
Memory	10001111	mod 0 0 0 r/m			20	24	
Register	01011 reg				10	14	
Segment register	000 reg 1 1 1	(reg≠01)			8	12	
POPA - Pop All	01100001				<b>51</b>	83	
XCHG = Exchange:							
Register/memory with register	1000011w	mod reg r/m			4/17	4/17*	
Register with accumulator	10010 reg				3	3	
IN = Input from:							
Fixed port	1110010w	port			10	10*	
Variable port	1110110w				8	8*	
OUT = Output to:							
Fixed port	1110011w	port			9	9*	
Variable port	1110111w				7	7*	
XLAT = Translate byte to AL	11010111				11	15	
LEA = Load EA to register	10001101	mod reg r/m			6	6	
LDS = Load pointer to DS	11000101	mod reg r/m	(mod≠11)		18	26	
LES = Load pointer to ES	11000100	mod reg r/m	(mod≠11)		18	26	
LAHF = Load AH with flags	10011111				2	2	
SAHF = Store AH into flags	10011110				3	3	
PUSHF = Push flags	10011100				9	13	
POPF = Pop flags	10011101				8	12	

Shaded areas indicate instructions not available in 8086/8088 microsystems.

PRELIMINARY

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<sup>\*</sup>Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for all memory transfers.

# 80C186EC/188EC, 80L186EC/188EC



**INSTRUCTION SET SUMMARY** (Continued)

Function		For	mat		80C186EC Clock Cycles	80C188EC Clock Cycles	Comments
DATA TRANSFER (Continued) SEGMENT = Segment Override:							
cs	00101110				2	2	
ss	00110110				2	2	
os	00111110				2	2	
ES	00100110				2	2	
ARITHMETIC ADD = Add:	00,00,00				:		
Reg/memory with register to either	000000dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	100000sw	mod 0 0 0 r/m	data	data if s w = 01	4/16	4/16*	
Immediate to accumulator	0000010w	data	data if w = 1		3/4	3/4	8/16-bit
ADC = Add with carry:							
Reg/memory with register to either	000100dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	100000sw	mod 0 1 0 r/m	data	data if s w = 01	4/16	4/16*	
Immediate to accumulator	0001010w	data	data if w = 1		3/4	3/4	8/16-bit
INC = Increment:							
Register/memory	1111111w	mod 0 0 0 r/m			3/15	3/15*	
Register	01000 reg				3	3	
SUB = Subtract:							
Reg/memory and register to either	001010dw	mod reg r/m			3/10	3/10*	
Immediate from register/memory	100000sw	mod 1 0 1 r/m	data	data if s w = 01	4/16	4/16*	
Immediate from accumulator	0010110w	data	data if w ≖ 1	]	3/4	3/4*	8/16-bit
SBB = Subtract with borrow:							
Reg/memory and register to either	000110dw	mod reg r/m			3/10	3/10*	
Immediate from register/memory	100000sw	mod 0 1 1 r/m	data	data if s w = 01	4/16	4/16*	
Immediate from accumulator	0001110w	data	data if w=1	]	3/4	3/4*	8/16-bit
DEC = Decrement		. 1					
Register/memory	1111111W	mod 0 0 1 r/m			3/15	3/15*	
Register	01001 reg	J			3	3	
CMP = Compare:					3/10	3/10*	
Register/memory with register	0011101w	mod reg r/m					
Register with register/memory	0011100w	mod reg r/m			3/10	3/10*	
Immediate with register/memory	100000sw	mod 1 1 1 r/m	data	data if s w = 01	3/10	3/10*	
Immediate with accumulator	0011110w	data	data if w = 1	J	3/4	3/4	8/16-bit
NEG = Change sign register/memory	1111011w	mod 0 1 1 r/m	,		3/10	3/10*	]
AAA = ASCII adjust for add	00110111	Į			8	8	1
DAA = Decimal adjust for add	00100111	]			4	4	İ
AAS = ASCII adjust for subtract	00111111	Į			7	7	
DAS = Decimal adjust for subtract	00101111	J			4	4	
MUL = Multiply (unsigned):	1111011w	mod 100 r/m					
Register-Byte Register-Word Memory-Byte Memory-Word			-		26-28 35-37 32-34 41-43	26-28 35-37 32-34 41-43*	

Shaded areas indicate instructions not available in 8086/8088 microsystems.

NOTE:

\*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for all memory transfers.

1-240 4826175 0162097 897



ARITHMETIC (Continued)  IMUL = Integer multiply (signed):  Register-Byte Register-Word  Memory-Byte Memory-Word  IMUL = Integer Immediate multiply (signed)  DIV = Divide (unsigned):  Register-Byte Register-Word  Memory-Byte Memory-Word  IDIV = Integer divide (signed):  Register-Byte Register-Byte Register-Word  Memory-Byte  Memory-Word  IDIV = Integer divide (signed):  Register-Byte Register-Byte Register-Byte	1111011w .011010s1 1111011w	mod 1 0 1 r/m  mod reg f/m.  mod 1 1 0 r/m  mod 1 1 1 r/m		data if s = 0	25-28 34-37 31-34 40-43 22-25/ 29-32 29 38 35 44	25-28 34-37 32-34 40-43* 22-25/ 29-32 29 38 35 44*	
Register-Byte Register-Word Memory-Byte Memory-Word  MUL = integer immediate multiply (signed)  DIV = Divide (unsigned): Register-Byte Register-Word Memory-Byte Memory-Word IDIV = Integer divide (signed): Register-Byte Register-Byte Register-Byte Register-Byte	.011010s1	mod reg r/m. mod 1 1 0 r/m	The state of the s	data if s=0	34-37 31-34 40-43 22-25/ 29-32 29 38 35	34-37 32-34 40-43* 22-25/ 29-32 29 38 35	
INUL = integer (immediate multiply (signed):  DIV = Divide (unsigned):  Register-Byte Register-Word Memory-Byte Memory-Word IDIV = Integer divide (signed):  Register-Byte Register-Byte Register-Word	1111011w	mod 1 1 0 r/m	date	data if s = 0	22-25/ 29-32 29 38 35	22-25/ 29-32 29 38 35	
Register-Byte Register-Word Memory-Byte Memory-Word IDIV = Integer divide (signed): Register-Byte Register-Word		T	]		29 38 35	29 38 35	
Register-Byte Register-Word Memory-Byte Memory-Word IDIV = Integer divide (signed): Register-Byte Register-Word		T	]		38 35	38 35	
Register-Byte Register-Word	1111011w	mod 1 1 1 r/m	]				I
Register-Word			_		1		
Memory-Word			`		44-52 53-61 50-58 59-67	44-52 53-61 50-58 59-67*	
AAM = ASCII adjust for multiply	11010100	00001010			19	19	
AAD = ASCII adjust for divide	11010101	00001010			15	15	
CBW = Convert byte to word	10011000	]			2	2	
CWD = Convert word to double word ,	10011001	]			4	4	
OGIC Shift/Rotate Instructions:							
Register/Memory by 1	1101000w	mod TTT r/m			2/15	2/15	
Register/Memory by CL	1101001w	mod TTT r/m			5+n/17+n	5+n/17+n	
Register/Memory by Count	1100000w	mod TTT r/m	count		5+n/17+n	5+n/17+n	
NND = And:		TTT Instruction 000 ROL 001 ROR 010 RCL 011 RCR 110 SHL/SAL 111 SAR					
Reg/memory and register to either	001000dw	mod reg r/m			3/10	3/10*	
mmediate to register/memory	1000000w	mod 1 0 0 r/m	data	data if w = 1	4/16	4/16*	
mmediate to accumulator	0010010w	data	data if w = 1		3/4	3/4*	8/16-bit
EST = And function to flags, no result:				·			
Register/memory and register	1000010w	mod reg r/m		İ	3/10	3/10	
mmediate data and register/memory	1111011w	mod 0 0 0 r/m	data	data if w = 1	4/10	4/10*	
mmediate data and accumulator	1010100w	data	data if w = 1		3/4	3/4	8/16-bit
OR = Or:							
Reg/memory and register to either	000010dw	mod reg r/m			3/10	3/10*	
mmediate to register/memory	1000000w	mod 0 0 1 r/m	data	data if w = 1	4/16	4/16*	
nmediate to accumulator	0000110w	data	data if w = 1		3/4	3/4*	8/16-bit

Shaded areas indicate instructions not available in 8086/8088 microsystems.

\*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for all memory transfers.

PRELIMINARY

**4826175 0162098 726** 



Function		For	mat		80C186EC Clock Cycles	80C188EC Clock Cycles	Comments
LOGIC (Continued) XOR = Exclusive or:							
Reg/memory and register to either	001100dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	1000000w	mod 1 1 0 r/m	data	data if w = 1	4/16	4/16*	
Immediate to accumulator	0011010w	data	data if w = 1		3/4	3/4	8/16-bit
NOT = Invert register/memory	1111011w	mod 0 1 0 r/m			3/10	3/10*	
STRING MANIPULATION					İ		
MOVS = Move byte/word	1010010w				14	14*	
CMPS = Compare byte/word	1010011w				22	22*	
scas = Scan byte/word	1010111w				15	15*	
LODS = Load byte/wd to AL/AX	1010110w				12	12*	
STOS = Store byte/wd from AL/AX	1010101w				10	10*	
INS = Input byte/wd from DX port	0110110w				14	14	
OUTS = Output byte/wd to DX port	0110111W				14	14	
Repeated by count in CX (REP/REPE/F	REPZ/REPNE/REPN	NZ)					
MOVS = Move string	11110010	1010010w			8+8n	8+8n*	
CMPS = Compare string	1111001z	1010011w			5 + 22n	5 + 22n*	
SCAS = Scan string	1111001z	1010111w			5 + 15n	5+15n*	
LODS = Load string	11110010	1010110w			6+11n	6+11n*	
STOS = Store string	11110010	1010101w			6 + 9n	6+9n*	
INS = Input string	11110010	0110110w			8+8n	8+8n*	
OUTS = Output string	11110010	0110111w			8+8n	8+0m*	
CONTROL TRANSFER							
CALL = Call:				1			
Direct within segment	11101000	disp-low	disp-high	j	15	19	
Register/memory indirect within segment	11111111	mod 0 1 0 r/m			13/19	17/27	
-	10011010		nt offset	]	23	31	
Direct intersegment	10011010			]	20	"	
		segmen	t selector	j			
Indirect intersegment	11111111	mod 0 1 1 r/m	(mod ≠ 11)		38	54	
JMP = Unconditional jump:			_				
Short/long	11101011	disp-low	]		14	14	
Direct within segment	11101001	disp-low	disp-high	]	14	14	
Register/memory indirect within segment	1111111	mod 1 0 0 r/m			11/17	11/21	
Direct intersegment	11101010	segme	nt offset	]	14	14	
		segmen	t selector	]			
Indirect intersegment	11111111	mod 1 0 1 r/m	(mod ≠ 11)		26	34	}
manact utersegment		1 1100 1 0 1 1710	1 (				1

Shaded areas indicate instructions not available in 8086/8088 microsystems.

#### NOTE:

\*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for all memory transfers.

1-242 4826175 0162099 662



Function		Forma	t	80C186EC Clock Cycles	80C188EC Clock Cycles	Comments
CONTROL TRANSFER (Continued) RET = Return from CALL:						
Within segment	11000011			16	20	
Within seg adding immed to SP	11000010	data-low	data-high	18	22	
Intersegment	11001011			22	30	
Intersegment adding immediate to SP	11001010	data-low	data-high	25	33	
JE/JZ = Jump on equal/zero	01110100	disp	]	4/13	4/13	JMP not
JL/JNGE = Jump on less/not greater or equal	01111100	disp	]	4/13	4/13	taken/JMP taken
JLE/JNG = Jump on less or equal/not greater	01111110	disp	]	4/13	4/13	, wanter
JB/JNAE = Jump on below/not above or equal	01110010	disp	]	4/13	4/13	
JBE/JNA = Jump on below or equal/not above	01110110	disp	]	4/13	4/13	
JP/JPE = Jump on parity/parity even	01111010	disp	]	4/13	4/13	
JO = Jump on overflow	01110000	disp	]	4/13	4/13	
<b>JS</b> = Jump on sign	01111000	disp	}	4/13	4/13	
JNE/JNZ = Jump on not equal/not zero	01110101	disp	]	4/13	4/13	
JNL/JGE = Jump on not less/greater or equal	01111101	disp	]	4/13	4/13	
JNLE/JG = Jump on not less or equal/greater	01111111	disp	]	4/13	4/13	
JNB/JAE = Jump on not below/above or equal	01110011	disp	]	4/13	4/13	
JNBE/JA = Jump on not below or equal/above	01110111	disp	]	4/13	4/13	
JNP/JPO = Jump on not par/par odd	01111011	disp	]	4/13	4/13	
JNO = Jump on not overflow	01110001	disp	]	4/13	4/13	
JNS = Jump on not sign	01111001	disp	]	4/13	4/13	
JCXZ = Jump on CX zero	11100011	disp	]	5/15	5/15	
LOOP = Loop CX times	11100010	disp	]	6/16	6/16	LOOP not
LOOPZ/LOOPE = Loop while zero/equal	11100001	disp	]	6/16	6/16	taken/LOOf taken
LOOPNZ/LOOPNE = Loop while not zero/equal	11100000	disp	]	6/16	6/16	Latory
SNITES — Emer Procedura	11001000	data-low	data-high L			
				15 26 22+16(n=1)	19 29 26+20(n-1)	
LEAVE = Leave Procedure	11001001			8	8	
INT = Interrupt:						
Type specified	11001101	type	]	47	47	
Туре 3	11001100			45	45	if INT, taken/
INTO = Interrupt on overflow	11001110			48/4	48/4	if INT. not taken
IRET = Interrupt return	11001111	<u> </u>		28	28	
BOUND - Detect value out of range	01100010	med reg r/m		33-35	33-35	

Shaded areas indicate instructions not available in 8086/8088 microsystems.

#### NOTE:

PRELIMINARY

**4826175 0162100 104** 

<sup>\*</sup>Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for all memory transfers.



Function	Format	80C186EC Clock Cycles	80C188EC Clock Cycles	Comments
PROCESSOR CONTROL			T	
CLC = Clear carry	11111000	2	2	
CMC = Complement carry	11110101	2	2	
STC = Set carry	11111001	2	2	
CLD = Clear direction	1111100	2	2	
STD = Set direction	11111101	2	2	
CLI = Clear interrupt	11111010	2	2	
STI = Set interrupt	11111011	2	2	
HLT = Halt	11110100	2	2	
WAIT = Wait	10011011	6	6	if TEST = 0
LOCK = Bus lock prefix	11110000	2	2	
NOP = No Operation	10010000	3	3	
	(TTT LLL are opcode to processor extensi	on)		

Shaded areas indicate instructions not available in 8086/8088 microsystems.

### NOTE:

\*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for all memory transfers.

The Effective Address (EA) of the memory operand is computed according to the mod and r/m fields:

if mod = 11 then r/m is treated as a REG field if mod = 00 then DISP = 0\*, disp-low and disp-

high are absent if mod = 01 then DISP = disp-low sign-extended

to 16-bits, disp-high is absent

if mod = 10 then DISP = disp-high: disp-low if r/m = 000 then EA = (BX) + (Si) + DISP

if r/m = 001 then EA = (BX) + (DI) + DISP if r/m = 010 then EA = (BP) + (SI) + DISP if r/m = 011 then EA = (BP) + (DI) + DISP

if r/m = 100 then EA = (SI) + DISP

if r/m = 101 then EA = (DI) + DISP

if r/m = 110 then EA = (BP) + DISP\* if r/m = 111 then EA = (BX) + DISP

DISP follows 2nd byte of instruction (before data if required)

\*except if mod = 00 and r/m = 110 then EA = disp-high: disp-low.

EA calculation time is 4 clock cycles for all modes. and is included in the execution times given whenever appropriate.

# Seament Override Prefix reg

1

reg is assigned according to the following:

1 1

	Segment
reg	Register
00	ES
01	CS
10	SS
11	DS

REG is assigned according to the following table:

16-Bit (w = 1)	8-Bit ( $\mathbf{w} = 0$ )
000 AX	000 AL
001 CX	001 CL
010 DX	010 DL
011 BX	011 BL
100 SP	100 AH
101 BP	101 CH
110 SI	110 DH
111 DI	111 BH

The physical addresses of all operands addressed by the BP register are computed using the SS segment register. The physical addresses of the destination operands of the string primitive operations (those addressed by the DI register) are computed using the ES segment, which may not be overridden.

4826175 0162101 040



### **ERRATA**

An 80C186EC/80L186EC with a STEPID value of 0002H has no known errata. A device with a STEPID of 0002H can be visually identified by noting the **presence** of an "A" or "B" alpha character next to the FPO number or the absence of any alpha character. The FPO number location is shown in Figures 4, 5 and 6.

# **REVISION HISTORY**

This data sheet replaces the following data sheets:

272072-003 80C186EC 272076-003 80C188EC 272332-001 80L186EC 272333-001 80L188EC

272373-001 SB80C188EC/SB80L188EC 272372-001 SB80C186EC/SB80L186EC

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